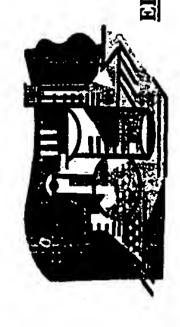
SEARCH REQUEST FORM Scientific and Technical Informati n Center

Bankara E. II Name W. V. 1 141	Examiner # - 7(1)=6 Date: 7/70/02
Requester's Full Name: Mikolas Utilir Art Unit: 1773 Phone Number 305-0179	Serial Number: 1997189/
Mail Box and Bldg/Room Location: <u>EP3-11-01</u> Resu	alts Format Preferred (circle) PAPER DISK E-MAIL
wan box and brag recom because on one of the second	
If more than one search is submitted, please prioritize	ze searches in order of need.
**************************************	or specifically as possible the subject matter to be searched
*Please provide a detailed statement of the search topic, and describe Include the elected species or structures, keywords, synonyms, acror	
utility of the invention. Define any terms that may have a special me	eaning. Give examples or relevant citations, authors, etc, if
known. Please attach a copy of the cover sheet, pertinent claims, and	abstract.
Title of Invention: Lampate	•
The of motion Court of the Theorem	awa; Maguki Konda; Kimuki
Inventors (please provide full names): 10075 1 669	GOWA, MAGORIER CONCES KIMICKI
Makuta	
Earliest Priority Filing Date: 6/6/00	
For Sequence Searches Only Please include all pertinent information	(parent, child, divisional, or issued patent numbers) along with the
appropriate serial number.	
appropriate serial number. 1. a Laminate comprising	a metal Cayer "
formed on the surface	of an insulating
a I I I don't the	substrate 13 polycpii
JUBSTICK JOHN SOUCH TO	to be weight of a fibrous
and contains 20-150 par	to by weight of a fibrous filler is a titowate, boraten
filler Wherein the Tibrous	11 11 11
a - Wallastowife having as	a average length between an average diometer between
of the second of the second of	an average diometer
20-120	
1-5 MM	
1 & Claim 1	where the substrate
The Company (of tholomide)	where the substrate is polyphen-lene sulfide, Policy lene polyphen-lene sulfide, Policy lene (etheronide) or Liquid crystel special loctonite and the substrate loctonite powdery condry filler is spherical constraints powdry filler is spherical rous filler is Aluminum borate and
Mylow 6, Mylow 600, partow) po	14 (etheranica) of Lique substrate
terephthalate, Pothisis in we	lactorite powery (amorphous))
poly oster) the till	u vashaped tille (kashin)
Curthela Contains a	filler is spherical
(3) Laminate at # 7 1 but -where the fib (4) Luminate as in #5 where the fib (4) Luminate as in #5 where the fib	horate and
(3) Lamipare A to the fib	rous filler is Aluminum out
(i) I MINATE 49 " TI - DE MINATE 19	
4) Luminate as in #3 whore the fib the spherical filler is	91 * x -7. See o Hached
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STAFF USE ONLY Type of Search	Vendors and cost where applicable
Searcher A Pulled NA Sequence (#)	STN_
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Search Results Feedback Form

The search results generated for your recent request are attached. If you have any questions or comments (compliments or complaints) about the scope or the results of the search, please contact the searcher whose name is circled below.

(Kathleen Fuller 308-4290) Eric Linnell 308-4143 John Calve 308-4139 All searchers are located in the library in CP3/4 3D62

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=> FILE HCAPLU

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```
hefamethylene dramine in a
hefamethylene dramine in a
hefamethylene dramine on a
polymer

7254 SEA FILE=REGISTRY ABB=ON 124-09-4/CRN

21123 SEA FILE=REGISTRY ABB=ON 100-21-0/CRN - Terephthalic acid in a polymer

597 SEA FILE=REGISTRY ABB=ON L5 AND L7
5 SEA FILE=REGISTRY ABB=ON L8 AND 2/NC - together

3 SEA FILE=REGISTRY ABB=ON WOLLASTONITE/CN

8692 SEA FILE=REGISTRY ABB=ON WOLLASTONITE/CN
=> D QUE
L5
L7
L8
L18
                 8692 SEA FILE=HCAPLUS ABB=ON L18 OR WOLLASTONITE OR CASIO3
L25
L27
                      1 SEA FILE=REGISTRY ABB=ON KAOLIN/CN
L28
                    79 SEA FILE=HCAPLUS ABB=ON L27
L29
               35375 SEA FILE=HCAPLUS ABB=ON
                                                               ( L28 OR KAOLIN/BI)
               17963 SEA FILE=HCAPLUS ABB=ON
                                                               LAMINAT? (S) METAL?
L31
L73
                  199 SEA FILE-HCAPLUS ABB-ON
                 6172 SEA FILE=HCAPLUS ABB=ON L73 OR ?PHTHALAMID?
L74
                     O SEA FILE=HCAPLUS ABB=ON L74 AND L31 AND L25 AND L29
L76
                     O SEA FILE=HCAPLUS ABB=ON L74 AND L31 AND L25 AND CLAY#
L77
L78
                     O SEA FILE=HCAPLUS ABB=ON L76 OR L77
```

=>

"UHLIR 09/871896 Page 1

=> FILE REGISTRY

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STRUCTURE FILE UPDATES: 20 MAR 2002 HIGHEST RN 402467-99-6 DICTIONARY FILE UPDATES: 20 MAR 2002 HIGHEST RN 402467-99-6

TSCA INFORMATION NOW CURRENT THROUGH July 7, 2001

Please note that search-term pricing does apply when conducting SmartSELECT searches.

Crossover limits have been increased. See HELP CROSSOVER for details.

Calculated physical property data is now available. See HELP PROPERTIES for more information. See STNote 27, Searching Properties in the CAS Registry File, for complete details: http://www.cas.org/ONLINE/STN/STNOTES/stnotes27.pdf

The P indicator for Preparations was not generated for all of the CAS Registry Numbers that were added to the H/Z/CA/CAplus files between 12/27/01 and 1/23/02. Use of the P indicator in online and SDI searches during this period, either directly appended to a CAS Registry Number or by qualifying an L-number with /P, may have yielded incomplete results. As of 1/23/02, the situation has been resolved. Also, note that searches conducted using the PREP role indicator were not affected.

Customers running searches and/or SDIs in the H/Z/CA/CAplus files incorporating CAS Registry Numbers with the P indicator between 12/27/01 and 1/23/02, are encouraged to re-run these strategies. Contact the CAS Help Desk at 1-800-848-6533 in North America or 1-614-447-3698, worldwide, or send an e-mail to help@cas.org for further assistance or to receive a credit for any duplicate searches.

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`UHLIR 09/871896 Page 2

=> D QUE L36

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The P indicator for Preparations was not generated for all of the CAS Registry Numbers that were added to the CAS files between 12/27/01 and 1/23/02. As of 1/23/02, the situation has been resolved. Searches and/or SDIs in the H/Z/CA/CAplus files incorporating CAS Registry Numbers with the P indicator executed between 12/27/01 and 1/23/02 may be incomplete. See the NEWS message on this topic for more information.

```
9067 SEA FILE=REGISTRY ABB=ON 107-21-1/CRN AND 100-21-0/CRN
 L12
 L13
               6 SEA FILE=REGISTRY ABB=ON L12 AND 2/NC
 L18
               3 SEA FILE=REGISTRY ABB=ON WOLLASTONITE/CN
           53533 SEA FILE=HCAPLUS ABB=ON L13
 L22
 L23
           59439 SEA FILE-HCAPLUS ABB-ON L22 OR ?PHTHALAMID?
 L25
            8692 SEA FILE=HCAPLUS ABB=ON L18 OR WOLLASTONITE OR CASIO3
 L27
               1 SEA FILE=REGISTRY ABB=ON KAOLIN/CN
              79 SEA FILE=HCAPLUS ABB=ON L27
 L28
           35375 SEA FILE=HCAPLUS ABB=ON ( L28 OR KAOLIN/BI)
 L29
           17963 SEA FILE=HCAPLUS ABB=ON LAMINAT? (S) METAL?
 L31
 L32
              25 SEA FILE=HCAPLUS ABB=ON L25 AND L31
               O SEA FILE=HCAPLUS ABB=ON L29 AND L32 AND L23
 L34
 L35
               O SEA FILE=HCAPLUS ABB=ON L31 AND L23 AND L25 AND CLAY#
               O SEA FILE=HCAPLUS ABB=ON L34 OR L35
 L36
 => D QUE L61
              14 SEA FILE=REGISTRY ABB=ON (11121-16-7/BI OR 12047-27-7/BI OR
· L2
                 12049-50-2/BI OR 12673-69-7/BI OR 13983-17-0/BI OR 24968-12-5/B
                 I OR 25038-54-4/BI OR 25667-42-9/BI OR 31694-16-3/BI OR
                 32131-17-2/BI OR 7440-50-8/BI OR 7631-86-9/BI OR 88-96-0/BI OR
                 9003-18-3/BI)
               6 SEA FILE=REGISTRY ABB=ON L2 AND PMS/CI
 L10
            9067 SEA FILE=REGISTRY ABB=ON 107-21-1/CRN AND 100-21-0/CRN
 L12
               6 SEA FILE=REGISTRY ABB=ON L12 AND 2/NC
 L13
                                           "NYLON 6"/CN
 L14
               1 SEA FILE=REGISTRY ABB=ON
 L15
               1 SEA FILE=REGISTRY ABB=ON
                                            "NYLON 66"/CN
               3 SEA FILE=REGISTRY ABB=ON WOLLASTONITE/CN
 L18
 L19
              13 SEA FILE=REGISTRY ABB=ON L2 NOT L18
               2 SEA FILE=REGISTRY ABB=ON L19 AND (1/B OR 1/TI)
 L20
           53533 SEA FILE=HCAPLUS ABB=ON L13
 L22
           59439 SEA FILE=HCAPLUS ABB=ON L22 OR ?PHTHALAMID?
 L23
 L25
            8692 SEA FILE=HCAPLUS ABB=ON L18 OR WOLLASTONITE OR CASIO3
 L27
               1 SEA FILE=REGISTRY ABB=ON KAOLIN/CN
 L28
              79 SEA FILE=HCAPLUS ABB=ON L27
 L29
           35375 SEA FILE=HCAPLUS ABB=ON ( L28 OR KAOLIN/BI)
           17963 SEA FILE=HCAPLUS ABB=ON LAMINAT?(S)METAL?
 L31
            4058 SEA FILE=HCAPLUS ABB=ON L31 AND (L23 OR L10 OR L14 OR L15 OR
 L37
                 PPS OR POLYPHENYLENE (W) SULFIDE OR PET OR POLYETHYLENE TEREPHTHA
                 LATE OR PEK OR POLYETHER KETONE OR POLYETHER AMIDE? OR PEEK OR
                 POLYESTER? OR PEEK)
               2 SEA FILE=REGISTRY ABB=ON ALUMINUM BORATE/CN
 L38
             549 SEA FILE=HCAPLUS ABB=ON L38
 L39
 L40
          640986 SEA FILE=HCAPLUS ABB=ON L20 OR ?TITAN? OR ?BORAT? OR ( L39 OR
                 ALUMINUM BORATE/BI)
             384 SEA FILE=HCAPLUS ABB=ON L37 AND (L40 OR L25)
 L41
 L43
               1 SEA FILE=REGISTRY ABB=ON SILICON DIOXIDE/CN
 L44
          232851 SEA FILE=HCAPLUS ABB=ON L43
```

UHLIR	09/87189	Page 3
L45		CA FILE=HCAPLUS ABB=ON L41 AND (L29 OR CLAY# OR SIO2 OR LICA OR (L44 OR SILICON DIOXIDE/BI))
L47		A FILE=HCAPLUS ABB=ON L45 AND METAL? (3A) LAYER? (S) SUBSTRATE?
L48	6 SE	A FILE=HCAPLUS ABB=ON L45 AND INSULAT?
L49	14 SE	A FILE=HCAPLUS ABB=ON L47 OR L48
L50	1913 SE	A FILE=HCAPLUS ABB=ON L31 AND (THERMOPLASTIC? OR THERMOSET?)
L57	19 SE	A FILE=HCAPLUS ABB=ON L50 AND (FIBER? OR FIBROUS)(3A)FILLER?
L58	1 SE	A FILE=REGISTRY ABB=ON SILICON DIOXIDE/CN
L59	232851 SE	A FILE=HCAPLUS ABB=ON L58
L60		A FILE=HCAPLUS ABB=ON L57 AND (L29 OR CLAY# OR SIO2 OR LICA OR (L59 OR SILICON DIOXIDE/BI))
L61		A FILE=HCAPLUS ABB=ON L49 OR L60

=> FILE WPIX

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- >>> FOR DETAILS OF THE PATENTS COVERED IN CURRENT UPDATES,
 SEE http://www.derwent.com/dwpi/updates/dwpicov/index.html <<<

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=> D QUE L65
             14 SEA FILE=REGISTRY ABB=ON (11121-16-7/BI OR 12047-27-7/BI OR
L2
                12049-50-2/BI OR 12673-69-7/BI OR 13983-17-0/BI OR 24968-12-5/B
                I OR 25038-54-4/BI OR 25667-42-9/BI OR 31694-16-3/BI OR
                32131-17-2/BI OR 7440-50-8/BI OR 7631-86-9/BI OR 88-96-0/BI OR
                9003-18-3/BI)
              6 SEA FILE=REGISTRY ABB=ON L2 AND PMS/CI
L10
           9067 SEA FILE=REGISTRY ABB=ON 107-21-1/CRN AND 100-21-0/CRN
L12
L13
              6 SEA FILE=REGISTRY ABB=ON L12 AND 2/NC
              1 SEA FILE=REGISTRY ABB=ON "NYLON 6"/CN
L14
              1 SEA FILE=REGISTRY ABB=ON "NYLON 66"/CN
L15
              3 SEA FILE=REGISTRY ABB=ON WOLLASTONITE/CN
L18
L19
             13 SEA FILE=REGISTRY ABB=ON L2 NOT L18
L20
              2 SEA FILE=REGISTRY ABB=ON L19 AND (1/B OR 1/TI)
          53533 SEA FILE=HCAPLUS ABB=ON L13
L22
L23
          59439 SEA FILE=HCAPLUS ABB=ON L22 OR ?PHTHALAMID?
L25
           8692 SEA FILE=HCAPLUS ABB=ON L18 OR WOLLASTONITE OR CASIO3
              1 SEA FILE=REGISTRY ABB=ON KAOLIN/CN
L27
L28
             79 SEA FILE=HCAPLUS ABB=ON L27
L29
          35375 SEA FILE=HCAPLUS ABB=ON ( L28 OR KAOLIN/BI)
          17963 SEA FILE=HCAPLUS ABB=ON LAMINAT?(S)METAL?
L31
L32
             25 SEA FILE=HCAPLUS ABB=ON L25 AND L31
              O SEA FILE=HCAPLUS ABB=ON L29 AND L32 AND L23
L34
```

UHLIR	09/87	1896 Page 4
L35	0	SEA FILE=HCAPLUS ABB=ON L31 AND L23 AND L25 AND CLAY#
L37	4058	SEA FILE=HCAPLUS ABB=ON L31 AND (L23 OR L10 OR L14 OR L15 OR
		PPS OR POLYPHENYLENE (W) SULFIDE OR PET OR POLYETHYLENE TEREPHTHA
		LATE OR PEK OR POLYETHER KETONE OR POLYETHER AMIDE? OR PEEK OR
		POLYESTER? OR PEEK)
L38	2	SEA FILE=REGISTRY ABB=ON ALUMINUM BORATE/CN
L39		SEA FILE=HCAPLUS ABB=ON L38
L40	640986	SEA FILE=HCAPLUS ABB=ON L20 OR ?TITAN? OR ?BORAT? OR (L39 OR
		ALUMINUM BORATE/BI)
L41		SEA FILE=HCAPLUS ABB=ON L37 AND (L40 OR L25)
L43		SEA FILE=REGISTRY ABB=ON SILICON DIOXIDE/CN
		SEA FILE=HCAPLUS ABB=ON L43
L45	106	SEA FILE=HCAPLUS ABB=ON L41 AND (L29 OR CLAY# OR SIO2 OR
- 45		SILICA OR (L44 OR SILICON DIOXIDE/BI))
L47	9	SEA FILE=HCAPLUS ABB=ON L45 AND METAL?(3A)LAYER?(S)SUBSTRATE?
L48	6	SEA FILE=HCAPLUS ABB=ON L45 AND INSULAT?
L49		SEA FILE=HCAPLUS ABB=ON L47 OR L48
L50		SEA FILE=HCAPLUS ABB=ON L31 AND (THERMOPLASTIC? OR THERMOSET?)
130	1913	obit fill nonthoo had on hor had thanked brotto. On indicating
L57	19	SEA FILE=HCAPLUS ABB=ON L50 AND (FIBER? OR FIBROUS) (3A) FILLER?
L58	1	SEA FILE=REGISTRY ABB=ON SILICON DIOXIDE/CN
L59		SEA FILE=HCAPLUS ABB=ON L58
L60	3	SEA FILE=HCAPLUS ABB=ON L57 AND (L29 OR CLAY# OR SIO2 OR
		SILICA OR (L59 OR SILICON DIOXIDE/BI))
L62		SEA FILE=WPIX ABB=ON L34 OR L35
L63		SEA FILE=WPIX ABB=ON L49 OR L60
L64		SEA FILE=WPIX ABB=ON L63 AND (METAL?(3A)LAYER?)
L65	4	SEA FILE=WPIX ABB=ON L62 OR L64
	-	

=> FILE COMPENDEX

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FILE COVERS 1970 TO DATE.

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=> D QUE L67
L2
            14 SEA FILE=REGISTRY ABB=ON (11121-16-7/BI OR 12047-27-7/BI OR
               12049-50-2/BI OR 12673-69-7/BI OR 13983-17-0/BI OR 24968-12-5/B
               I OR 25038-54-4/BI OR 25667-42-9/BI OR 31694-16-3/BI OR
               32131-17-2/BI OR 7440-50-8/BI OR 7631-86-9/BI OR 88-96-0/BI OR
               9003-18-3/BI)
L10
             6 SEA FILE=REGISTRY ABB=ON L2 AND PMS/CI
L12
          9067 SEA FILE=REGISTRY ABB=ON 107-21-1/CRN AND 100-21-0/CRN
             6 SEA FILE=REGISTRY ABB=ON L12 AND 2/NC
L13
             1 SEA FILE=REGISTRY ABB=ON "NYLON 6"/CN
L14
L15
            1 SEA FILE=REGISTRY ABB=ON "NYLON 66"/CN
L18
            3 SEA FILE=REGISTRY ABB=ON WOLLASTONITE/CN
L19
            13 SEA FILE=REGISTRY ABB=ON L2 NOT L18
L20
             2 SEA FILE=REGISTRY ABB=ON L19 AND (1/B OR 1/TI)
L22
         53533 SEA FILE=HCAPLUS ABB=ON L13
L23
         59439 SEA FILE=HCAPLUS ABB=ON L22 OR ?PHTHALAMID?
L25
          8692 SEA FILE=HCAPLUS ABB=ON L18 OR WOLLASTONITE OR CASIO3
             1 SEA FILE=REGISTRY ABB=ON KAOLIN/CN
L27
L28
            79 SEA FILE=HCAPLUS ABB=ON L27
L29
         35375 SEA FILE=HCAPLUS ABB=ON ( L28 OR KAOLIN/BI)
```

UHLIR	09/87	1896 Page 5
		SEA FILE=HCAPLUS ABB=ON LAMINAT?(S)METAL?
L37	4058	SEA FILE=HCAPLUS ABB=ON L31 AND (L23 OR L10 OR L14 OR L15 OR
		PPS OR POLYPHENYLENE(W) SULFIDE OR PET OR POLYETHYLENE TEREPHTHA
		LATE OR PEK OR POLYETHER KETONE OR POLYETHER AMIDE? OR PEEK OR
	,	POLYESTER? OR PEEK) SEA FILE=REGISTRY ABB=ON ALUMINUM BORATE/CN
L39		SEA FILE=HCAPLUS ABB=ON L38
L40	640986	SEA FILE=HCAPLUS ABB=ON L20 OR ?TITAN? OR ?BORAT? OR (L39 OR
		ALUMINUM BORATE/BI)
L41		SEA FILE=HCAPLUS ABB=ON L37 AND (L40 OR L25)
L43	1	SEA FILE=REGISTRY ABB=ON SILICON DIOXIDE/CN
L44	232851	SEA FILE=HCAPLUS ABB=ON L43
L45	106	SEA FILE-HCAPLUS ABB=ON L41 AND (L29 OR CLAY# OR SIO2 OR
		SILICA OR (L44 OR SILICON DIOXIDE/BI))
L47	9	SEA FILE=HCAPLUS ABB=ON L45 AND METAL?(3A)LAYER?(S)SUBSTRATE?
L48	6	SEA FILE=HCAPLUS ABB=ON L45 AND INSULAT?
L49		SEA FILE=HCAPLUS ABB=ON L47 OR L48
L50		SEA FILE-HCAPLUS ABB=ON L31 AND (THERMOPLASTIC? OR THERMOSET?)
В50	1717	OBA LIBE-NOALEOU ADD-ON DOL AND (INDICHOLDADITO: ON INDICHOSEI:)
L57	19	SEA FILE=HCAPLUS ABB=ON L50 AND (FIBER? OR FIBROUS) (3A) FILLER?
L58	1	SEA FILE=REGISTRY ABB=ON SILICON DIOXIDE/CN
L59		SEA FILE=HCAPLUS ABB=ON L58
L60		SEA FILE=HCAPLUS ABB=ON L57 AND (L29 OR CLAY# OR SIO2 OR
200	J	SILICA OR (L59 OR SILICON DIOXIDE/BI))
L67	Ω	SEA FILE=COMPENDEX ABB=ON L49 OR L60
10,		

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FILE LAST UPDATED: 18 MAR 2002 <20020318/UP>
FILE COVERS 1969 TO DATE.

=> D QUE L71 L2(11121-16-7/BI OR 12047-27-7/BI OR 14 SEA FILE=REGISTRY ABB=ON 12049-50-2/BI OR 12673-69-7/BI OR 13983-17-0/BI OR 24968-12-5/B I OR 25038-54-4/BI OR 25667-42-9/BI OR 31694-16-3/BI OR 32131-17-2/BI OR 7440-50-8/BI OR 7631-86-9/BI OR 88-96-0/BI OR · 9003-18-3/BI) 6 SEA FILE=REGISTRY ABB=ON L2 AND PMS/CI L109067 SEA FILE=REGISTRY ABB=ON 107-21-1/CRN AND 100-21-0/CRN L12 6 SEA FILE=REGISTRY ABB=ON L12 AND 2/NC L13 L14 1 SEA FILE=REGISTRY ABB=ON "NYLON 6"/CN "NYLON 66"/CN L15 1 SEA FILE=REGISTRY ABB=ON 3 SEA FILE=REGISTRY ABB=ON WOLLASTONITE/CN L18 L19 13 SEA FILE=REGISTRY ABB=ON L2 NOT L18 L20 2 SEA FILE=REGISTRY ABB=ON L19 AND (1/B OR 1/TI) L22 53533 SEA FILE=HCAPLUS ABB=ON L13 59439 SEA FILE=HCAPLUS ABB=ON L22 OR ?PHTHALAMID? L23 L25 8692 SEA FILE=HCAPLUS ABB=ON L18 OR WOLLASTONITE OR CASIO3 L27 1 SEA FILE=REGISTRY ABB=ON KAOLIN/CN L28 79 SEA FILE=HCAPLUS ABB=ON L27 35375 SEA FILE=HCAPLUS ABB=ON (L28 OR KAOLIN/BI) L29 L31 17963 SEA FILE=HCAPLUS ABB=ON LAMINAT?(S)METAL? 25 SEA FILE=HCAPLUS ABB=ON L25 AND L31 L32 L34 O SEA FILE=HCAPLUS ABB=ON L29 AND L32 AND L23

UHLIR	09/871	1896 Page 6
L35	0	SEA FILE=HCAPLUS ABB=ON L31 AND L23 AND L25 AND CLAY#
L37	4058	SEA FILE=HCAPLUS ABB=ON L31 AND (L23 OR L10 OR L14 OR L15 OR
		PPS OR POLYPHENYLENE(W) SULFIDE OR PET OR POLYETHYLENE TEREPHTHA
		LATE OR PEK OR POLYETHER KETONE OR POLYETHER AMIDE? OR PEEK OR
- 00	0	POLYESTER? OR PEEK)
L38		SEA FILE=REGISTRY ABB=ON ALUMINUM BORATE/CN
L39		SEA FILE=HCAPLUS ABB=ON L38
L40	640986	SEA FILE=HCAPLUS ABB=ON L20 OR ?TITAN? OR ?BORAT? OR (L39 OR
T 4.1	204	ALUMINUM BORATE/BI)
L41		SEA FILE=HCAPLUS ABB=ON L37 AND (L40 OR L25) SEA FILE=REGISTRY ABB=ON SILICON DIOXIDE/CN
L43 L44		SEA FILE=HCAPLUS ABB=ON L43
L45		SEA FILE-HCAPLUS ABB=ON L41 AND (L29 OR CLAY# OR SIO2 OR
П4Э	100	SILICA OR (L44 OR SILICON DIOXIDE/BI))
L47	. 9	SEA FILE=HCAPLUS ABB=ON L45 AND METAL? (3A) LAYER? (S) SUBSTRATE?
	_	
L48	6	SEA FILE=HCAPLUS ABB=ON L45 AND INSULAT?
L49	14	SEA FILE=HCAPLUS ABB=ON L47 OR L48
L50	1913	SEA FILE=HCAPLUS ABB=ON L31 AND (THERMOPLASTIC? OR THERMOSET?)
L57	19	SEA FILE=HCAPLUS ABB=ON L50 AND (FIBER? OR FIBROUS) (3A) FILLER?
	_	
L58		SEA FILE=REGISTRY ABB=ON SILICON DIOXIDE/CN
L59		SEA FILE=HCAPLUS ABB=ON L58
L60	3	SEA FILE=HCAPLUS ABB=ON L57 AND (L29 OR CLAY# OR SIO2 OR
T C O	^	SILICA OR (L59 OR SILICON DIOXIDE/BI))
L69		SEA FILE=INSPEC ABB=ON L34 OR L35
L70 L71		SEA FILE=INSPEC ABB=ON L49 OR L60 SEA FILE=INSPEC ABB=ON L69 OR L70
ъ/т		SEM LIBE-INSPEC MEE-ON 103 ON 11/0

=> DUP REM L61 L65

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FILE 'WPIX' ENTERED AT 16:10:17 ON 22 MAR 2002
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PROCESSING COMPLETED FOR L61
PROCESSING COMPLETED FOR L65
L72
20 DUP REM L61 L65 (0 DUPLICATES REMOVED)

=> D L72 ALL 1-20 HITSTR

L72 ANSWER 1 OF 20 HCAPLUS COPYRIGHT 2002 ACS

AN 2002:15845 HCAPLUS

DN 136:86860

TI Fabrication of antireflective film by forming a corroded metal layer

IN Iwama, Isao; Omo, Noriaki

PA Nissha Printing Co., Ltd., Japan

SO Jpn. Kokai Tokkyo Koho, 6 pp. CODEN: JKXXAF

DT Patent

LA Japanese

IC ICM B32B015-08

ICS B32B015-08; B29C045-14; B32B007-02; G02B001-11; B29K101-00; B29L007-00; B29L009-00; B29L011-00

CC 38-3 (Plastics Fabrication and Uses) Section cross-reference(s): 56

```
FAN.CNT 1
     PATENT NO.
                      KIND DATE
                                           APPLICATION NO. DATE
    JP 2002001867 A2
                            20020108
                                           JP 2000-192062
                                                            20000627
PΙ
    Title antireflective film is fabricated by laminating on (A) a
AB
     transparent substrate (e.g., an acrylic resin), (B) an adhesive
     layer (acrylic), (C) corroded metal layer
     (aluminum), (D) printed layer (acrylic gravure), (E) releasing layer
     (UV-cured epoxy), (F) low reflective layer (alternate between
     silica and titania), and (G) antistaining layer
     (fluorine-contg. silane). Thus, layers (E)-(B) were sequentially formed
     on a PET film and transferred to a transparent substrate in an
     injection-mold, and finally layers (f) and (G) were formed on top of layer
     corroded aluminum deposition film antireflective laminate
ST
IT
     Epoxy resins, uses
     RL: TEM (Technical or engineered material use); USES (Uses)
        (UV-cured; as releasing layer for antireflective laminate)
    Coating materials
IT
        (antistaining; for laminated antireflective film)
    Laminated plastics, uses
ΙT
     RL: PEP (Physical, engineering or chemical process); PYP (Physical
     process); TEM (Technical or engineered material use); PROC (Process); USES
     (Uses)
        (as antireflective film)
    Acrylic polymers, uses
IT
     RL: PEP (Physical, engineering or chemical process); PYP (Physical
     process); TEM (Technical or engineered material use); PROC (Process); USES
     (Uses)
        (as transparent substrate for antireflective laminate)
    Antireflective films
IT
        (contq. corroded metal layer)
IT
     Silanes
     RL: TEM (Technical or engineered material use); USES (Uses)
        (fluoro; as antistaining coating material for laminated antireflective
        film)
     Polyesters, miscellaneous
ΙT
     RL: MSC (Miscellaneous)
        (for transfer-molding of antireflective film)
    Molding of plastics and rubbers
        (transfer; in prepn. of antireflective laminate)
     Vapor deposition process
ΙT
        (vacuum; of metal layer for antireflective laminate
     13463-67-7, Titania, uses
IT
     RL: TEM (Technical or engineered material use); USES (Uses)
        (alternate with silica as low-reflective layer for
        antireflective laminate)
    7631-86-9, Silica, uses
ΙT
     RL: TEM (Technical or engineered material use); USES (Uses)
        (alternate with titania as low-reflective layer for
        antireflective laminate)
     7429-90-5, Aluminum, uses
ΙT
     RL: TEM (Technical or engineered material use); USES (Uses)
        (corroded vacuum-deposited metal layer for antireflective
        laminate based on)
   25038-59-9, PET (polyester), miscellaneous
    RL: MSC (Miscellaneous)
        (for transfer-molding of antireflective film)
     7631-86-9, Silica, uses
```

IT

09/871896 Page 8 UHLIR RL: TEM (Technical or engineered material use); USES (Uses) (alternate with titania as low-reflective layer for antireflective laminate) 7631-86-9 HCAPLUS RN Silica (7CI, 8CI, 9CI) (CA INDEX NAME) CN o = si = o25038-59-9, PET (polyester), miscellaneous ΙT RL: MSC (Miscellaneous) (for transfer-molding of antireflective film) 25038-59-9 HCAPLUS RN Poly(oxy-1,2-ethanediyloxycarbonyl-1,4-phenylenecarbonyl) (9CI) (CA INDEX . CN NAME) J n L72 ANSWER 2 OF 20 HCAPLUS COPYRIGHT 2002 ACS AN2001:713755 HCAPLUS 135:274111 DN Polybutadiene- and polyisoprene based thermosetting compositions TIas circuit board substrates Landi, Vincent R. INPAWorld Properties, Inc., USA PCT Int. Appl., 31 pp. SO CODEN: PIXXD2 DTPatent English LA ICICM H05K001-03 39-9 (Synthetic Elastomers and Natural Rubber) CC Section cross-reference(s): 76 FAN.CNT 1 PATENT NO. KIND DATE APPLICATION NO. DATE 20010927 WO 2001072095 A2 WO 2001-US40338 20010321 PΙ А3 WO 2001072095 20020131 W: AE, AG, AL, AM, AT, AU, AZ, BA, BB, BG, BR, BY, BZ, CA, CH, CN, CO, CR, CU, CZ, DE, DK, DM, DZ, EE, ES, FI, GB, GD, GE, GH, GM, HR, HU, ID, IL, IN, IS, JP, KE, KG, KP, KR, KZ, LC, LK, LR, LS, LT, LU, LV, MA, MD, MG, MK, MN, MW, MX, MZ, NO, NZ, PL, PT, RO, RU, SD, SE, SG, SI, SK, SL, TJ, TM, TR, TT, TZ, UA, UG, UZ, VN, YU, ZA, ZW, AM, AZ, BY, KG, KZ, MD, RU, TJ, TM RW: GH, GM, KE, LS, MW, MZ, SD, SL, SZ, TZ, UG, ZW, AT, BE, CH, CY, DE, DK, ES, FI, FR, GB, GR, IE, IT, LU, MC, NL, PT, SE, TR, BF, BJ, CF, CG, CI, CM, GA, GN, GW, ML, MR, NE, SN, TD, TG PRAI US 2000-531947 A 20000321 The flame retardant compns., curable at low temp. and having improved ΑB

stability in dielec. const. and mech. properties with thermal aging, comprise: (A) a **thermosetting** polybutadiene or polyisoprene resin, (B) up to 20% (based on total resins) a ethylene propylene rubber with mol. wt. <50,000, (C) 20-60 phr flame retardant, (D) up to 50 vol% fabric, (E) up to 65 vol% filler and (E) effective amt. of peroxide curing agent, and a circuit board comprises a substrate from title compn. and a conductive **metal** layer, e.g., copper layer, **laminated** to the substrate.

- ST polybutadiene polyisoprene flame retardant thermosetting compn; ethylene propylene rubber low temp curable compn; copper conductive layer circuit board
- IT Styrene-butadiene rubber, properties
 RL: PEP (Physical, engineering or chemical process); POF (Polymer in formulation); PRP (Properties); TEM (Technical or engineered material use); PROC (Process); USES (Uses)

(block, Kraton D-KX 410CS; polybutadiene- and polyisoprene based thermosetting compns. as circuit board substrates)

IT Styrene-butadiene rubber, properties
RL: PEP (Physical, engineering or chemical process); POF (Polymer in formulation); PRP (Properties); TEM (Technical or engineered material use); PROC (Process); USES (Uses)

(block, diblock, Kraton D 1118X; polybutadiene- and polyisoprene based thermosetting compns. as circuit board substrates)

Styrene-butadiene rubber, properties
RL: PEP (Physical, engineering or chemical process); POF (Polymer in formulation); PRP (Properties); TEM (Technical or engineered material use); PROC (Process); USES (Uses)

(block, triblock, Vector 8508D; polybutadiene- and polyisoprene based thermosetting compns. as circuit board substrates)

IT EPDM rubber

RL: PEP (Physical, engineering or chemical process); POF (Polymer in formulation); PRP (Properties); TEM (Technical or engineered material use); PROC (Process); USES (Uses)

(dicyclopentadiene-ethylene-propene, Trilene 54; polybutadiene- and polyisoprene based thermosetting compns. as circuit board substrates)

IT Glass fibers, uses

RL: MOA (Modifier or additive use); USES (Uses)
(filler; polybutadiene- and polyisoprene based
thermosetting compns. as circuit board substrates)

IT Butadiene rubber, properties

RL: PEP (Physical, engineering or chemical process); POF (Polymer in formulation); PRP (Properties); TEM (Technical or engineered material use); PROC (Process); USES (Uses)

(of 1,2-configuration, B 3000; polybutadiene- and polyisoprene based thermosetting compns. as circuit board substrates)

IT Printed circuit boards

(using polybutadiene- and polyisoprene based thermosetting compns. as substrate)

IT Polymer blends

RL: PEP (Physical, engineering or chemical process); PRP (Properties); TEM (Technical or engineered material use); PROC (Process); USES (Uses) (using polybutadiene- and polyisoprene based thermosetting compns. as substrate)

IT 9003-17-2

RL: PEP (Physical, engineering or chemical process); POF (Polymer in formulation); PRP (Properties); TEM (Technical or engineered material use); PROC (Process); USES (Uses)

(butadiene rubber, of 1,2-configuration, B 3000; polybutadiene- and polyisoprene based thermosetting compns. as circuit board

substrates)

IT 7440-50-8, Copper, uses

RL: TEM (Technical or engineered material use); USES (Uses) (conductive layer; polybutadiene- and polyisoprene based

thermosetting compns. as circuit board substrates)

IT **7631-86-9**, CE 44I, uses

RL: MOA (Modifier or additive use); USES (Uses)

(filler, CE 44I; polybutadiene- and polyisoprene based

thermosetting compns. as circuit board substrates)

1T 409-21-2, Silicon carbide, uses 1304-56-9, Beryllia, uses 1309-48-4, Magnesia, uses 1344-28-1, Alumina, uses 10043-11-5, Boron nitride, uses 12047-27-7, Barium titanate, uses 12060-59-2, Strontium titanate 13463-67-7, Titanium dioxide, uses 24304-00-5, Aluminum nitride RL: MOA (Modifier or additive use); USES (Uses)

(filler; polybutadiene- and polyisoprene based thermosetting compns. as circuit board substrates)

IT 32588-76-4, BT 93WFG

RL: MOA (Modifier or additive use); USES (Uses)

(flame retardant, BT 93WFG; polybutadiene- and polyisoprene based thermosetting compns. as circuit board substrates)

IT 25034-71-3, Dicyclopentadiene-ethylene-propenecopolymer
RL: PEP (Physical, engineering or chemical process); POF (Polymer in formulation); PRP (Properties); TEM (Technical or engineered material use); PROC (Process); USES (Uses)

(rubber; polybutadiene- and polyisoprene based thermosetting compns. as circuit board substrates)

IT 106107-54-4

RL: PEP (Physical, engineering or chemical process); POF (Polymer in formulation); PRP (Properties); TEM (Technical or engineered material use); PROC (Process); USES (Uses)

(styrene-butadiene rubber, block, Kraton D-KX 410CS; polybutadiene- and polyisoprene based thermosetting compns. as circuit board substrates)

IT 106107-54-4

RL: PEP (Physical, engineering or chemical process); POF (Polymer in formulation); PRP (Properties); TEM (Technical or engineered material use); PROC (Process); USES (Uses)

(styrene-butadiene rubber, block, diblock, Kraton D 1118X; polybutadiene- and polyisoprene based thermosetting compns. as circuit board substrates)

IT 106107-54-4

RL: PEP (Physical, engineering or chemical process); POF (Polymer in formulation); PRP (Properties); TEM (Technical or engineered material use); PROC (Process); USES (Uses)

(styrene-butadiene rubber, block, triblock, Vector 8508D; polybutadiene- and polyisoprene based thermosetting compns. as circuit board substrates)

IT **7631-86-9**, CE 44I, uses

RL: MOA (Modifier or additive use); USES (Uses) (filler, CE 44I; polybutadiene- and polyisoprene based thermosetting compns. as circuit board substrates)

RN 7631-86-9 HCAPLUS

CN Silica (7CI, 8CI, 9CI) (CA INDEX NAME)

o = si = o

L72 ANSWER 3 OF 20 HCAPLUS COPYRIGHT 2002 ACS

```
2001:805245 HCAPLUS
AN
DN
     135:345952
    Peel-apart metal compound thin film layer laminate
TI
     used for transfer of metal compound layer onto other material or
     forming foil or powder
    Taniuchi, Takahiro; Inoue, Masahiro
IN
    Oike Industry Co., Ltd., Japan
PA
     Jpn. Kokai Tokkyo Koho, 4 pp.
SO
    CODEN: JKXXAF
    Patent
DT
LA
     Japanese
    ICM B32B009-00
IC
     ICS B44C001-17
     42-11 (Coatings, Inks, and Related Products)
CC
     Section cross-reference(s): 57, 75
FAN. CNT 1
     PATENT NO.
                                          APPLICATION NO.
                      KIND DATE
                                                            DATE
    JP 2001310411 A2
                            20011106
                                          JP 2000-131982
                                                            20000501
PI
    The laminate comprises, successively from the bottom, a
AB
     substrate film (S), a metal thin film layer
     (M), and a metal compd. thin film layer (C) of 5-300
     .mu.m thickness; wherein adhesion between S and M is stronger than that
    between M and C. The laminate is free from an org. release layer. Thus,
     a polyethylene terephthalate film laminated with a Au
     layer and a Si oxide layer was applied on an acrylic polymer sheet via an
    urethane-acrylic adhesive and hot pressed to bond only the Si oxide layer,
    and the Au/PET laminate was peeled off. The transferred Si oxide
    layer was free from org. components or pollutants.
    metal compd thin film laminate transfer; silicon oxide
ST
    thin layer transfer; indium tin oxide thin layer transfer; oxide metal
    thin layer transfer material; nitride metal thin layer transfer material;
    oxynitride metal thin layer transfer material; foil metal compd
    manuf transfer peelable laminate; powder metal compd
    manuf transfer peelable laminate; peel apart metal
    compd laminate transfer
    Metals, uses
IT
    RL: TEM (Technical or engineered material use); USES (Uses)
        (in laminate; peel-apart metal compd. thin film
       layer laminate used for transfer of metal compd.
       layer onto other material or forming foil or powder)
IT
     Foils
     Powders
        (metal compd., manuf.; peel-apart metal compd. thin
       film layer laminate used for transfer of metal
       compd. layer onto other material or forming foil or powder)
    Laminated plastic films
IT
    Transfers
        (peel-apart metal compd. thin film layer laminate
       used for transfer of metal compd. layer onto other material
       or forming foil or powder)
    Polyesters, uses
IT
    RL: TEM (Technical or engineered material use); USES (Uses)
        (substrate in laminate; peel-apart metal
        compd. thin film layer laminate used for transfer
       of metal compd. layer onto other material or
        forming foil or powder)
IT
     Nitrides
    Oxides (inorganic), uses
    Oxynitrides
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09/871896 Page 11

UHLIR

UHLIR 09/871896 Page 12

RL: TEM (Technical or engineered material use); USES (Uses) (thin film; peel-apart metal compd. thin film layer laminate used for transfer of metal compd. layer onto other material or forming foil or powder) 25038-59-9, Polyethylene terephthalate, uses ΙT RL: TEM (Technical or engineered material use); USES (Uses) (substrate in laminate; peel-apart metal compd. thin film layer laminate used for transfer of metal compd. layer onto other material or forming foil or powder) 7440-06-4, Platinum, uses 7440-22-4, Silver, uses 7440-57-5, Gold, IT uses RL: TEM (Technical or engineered material use); USES (Uses) (thin film layer, in laminate; peel-apart metal compd. thin film layer laminate used for transfer of metal compd. layer onto other material or forming foil or powder) 1312-43-2, Indium oxide 1332-29-2, Tin oxide IT1344-28-1, Aluminum oxide, uses 7631-86-9, Silicon oxide, uses 11105-01-4, Silicon oxynitride 12033-89-5, Silicon nitride, uses 12633-97-5, Aluminum 13463-67-7, **Titanium** oxide, uses oxynitride 24304-00-5, 25617-98-5, 25583-20-4, **Titanium** nitride Aluminum nitride Indium nitride 37271-26-4, **Titanium** oxynitride 50926-11-9, 55574-97-5, Tin nitride Indium tin oxide 116517-57-8, Indium oxynitride 130988-77-1, Tin oxynitride RL: TEM (Technical or engineered material use); USES (Uses) (thin film; peel-apart metal compd. thin film layer laminate used for transfer of metal compd. layer onto other material or forming foil or powder) 25038-59-9, Polyethylene terephthalate, uses ITRL: TEM (Technical or engineered material use); USES (Uses) (substrate in laminate; peel-apart metal compd. thin film layer laminate used for transfer of metal compd. layer onto other material or forming foil or powder) 25038-59-9 HCAPLUS RN Poly(oxy-1,2-ethanediyloxycarbonyl-1,4-phenylenecarbonyl) (9CI) CN (CA INDEX NAME)

o = si = 0

```
L72 ANSWER 4 OF 20 HCAPLUS COPYRIGHT 2002 ACS
     2001:705075 HCAPLUS
AN
    135:264333
DN
    Antireflective conductive transparent laminates and image display
TI
     apparatus
    Yamada, Tsukasa; Matsufuji, Akihiro
ΙN
     Fuji Photo Film Co., Ltd., Japan
PΑ
    Jpn. Kokai Tokkyo Koho, 9 pp.
SO
     CODEN: JKXXAF
DT
    Patent
LA
     Japanese
IC
     ICM G02B001-11
     ICS B32B007-02; B32B027-00; G02B001-10; G02F001-1335; H01B005-14;
          H04N005-72
    73-11 (Optical, Electron, and Mass Spectroscopy and Other Related
CC
     Properties)
FAN.CNT 1
     PATENT NO. KIND DATE
                                          APPLICATION NO. DATE
                           20010926
    JP 2001264505 A2
                                          JP 2000-71199
PΙ
                                                           20000314
    The laminates, suitable for use on image display screens,
AB
     comprise: a transparent plastic film substrate; a hard coating
     layer contg. Al203, SiO2, TiO2 and ZrO2; a transparent
     conductive plastic layer contg. fine metal particles;
     an antireflective multilayer; and a transparent anticontamination layer.
     antireflective conductive transparent laminate image display
ST
    Antireflective films
IT
     Electromagnetic wave
    Laminated materials
    Optical dispersion
    Optical imaging devices
    Polymerization
     Refractive index
        (antireflective conductive transparent laminates and image display
       app.)
    Polyesters, uses
IT
     RL: DEV (Device component use); USES (Uses)
        (antireflective conductive transparent laminates and image display
       app.)
    1314-23-4, Zirconium dioxide, uses 1344-28-1, Alumina, uses 7440-22-4,
\operatorname{IT}
    Silver, uses 7631-86-9, Silica, uses 13463-67-7,
     Titanium oxide (TiO2), uses 25038-59-9,
     Polyethyleneterephthalate, uses 29570-58-9, DPHA
     RL: DEV (Device component use); USES (Uses)
        (antireflective conductive transparent laminates and image display
       app.)
    7631-86-9, Silica, uses 25038-59-9,
IT
    Polyethyleneterephthalate, uses
     RL: DEV (Device component use); USES (Uses)
        (antireflective conductive transparent laminates and image display
       app.)
    7631-86-9 HCAPLUS
RN
     Silica (7CI, 8CI, 9CI) (CA INDEX NAME)
CN
```

0== Si== 0

RN 25038-59-9 HCAPLUS

CN Poly(oxy-1,2-ethanediyloxycarbonyl-1,4-phenylenecarbonyl) (9CI) (CA INDEX NAME)

L72 ANSWER 5 OF 20 HCAPLUS COPYRIGHT 2002 ACS

AN 2001:707518 HCAPLUS

DN 135:264344

TI Antireflective conductive transparent laminates and image display apparatus

IN Yamada, Tsukasa; Matsutou, Akihiro; Hatakeyama, Kenichiro

PA Fuji Photo Film Co., Ltd., Japan

SO Jpn. Kokai Tokkyo Koho, 9 pp. CODEN: JKXXAF

DT Patent

LA Japanese

IC ICM G02B001-11

ICS B32B007-02; G02B001-10; G02F001-1335; H01B005-14; H01J029-89; H04N005-72

CC 73-11 (Optical, Electron, and Mass Spectroscopy and Other Related Properties)

FAN.CNT 1

PATENT NO. KIND DATE APPLICATION NO. DATE

PI JP 2001264503 A2 20010926 JP 2000-71190 20000314

The laminates, suitable for use on image display screens, comprise: a transparent plastic film substrate; a hard coating layer contg. Al2O3, SiO2, TiO2 and ZrO2; a transparent conductive plastic layer contg. metal particles; an antireflective multilayer; and a transparent plastic anticontamination layer.

ST antireflective conductive transparent laminate image display

IT Antireflective films

Electromagnetic wave

Laminated materials

Optical dispersion

Optical imaging devices

Polymerization

Refractive index

(antireflective conductive transparent laminates and image display app.)

IT Polyesters, uses

RL: DEV (Device component use); USES (Uses) (antireflective conductive transparent laminates and image display

UHLIR 09/871896 Page 15

app.)

IT 1314-23-4, Zirconium dioxide, uses 1344-28-1, Alumina, uses 7440-22-4, Silver, uses 7631-86-9, Silica, uses 13463-67-7,

Titanium oxide (TiO2), uses 25038-59-9,

Polyethyleneterephthalate, uses 29570-58-9, DPHA

RL: DEV (Device component use); USES (Uses)

(antireflective conductive transparent laminates and image display app.)

IT 7631-86-9, Silica, uses 25038-59-9,

Polyethyleneterephthalate, uses

RL: DEV (Device component use); USES (Uses)

(antireflective conductive transparent laminates and image display

app.)

RN 7631-86-9 HCAPLUS

CN Silica (7CI, 8CI, 9CI) (CA INDEX NAME)

o = si = o

RN 25038-59-9 HCAPLUS

CN Poly(oxy-1,2-ethanediyloxycarbonyl-1,4-phenylenecarbonyl) (9CI) (CA INDEX NAME)

L72 ANSWER 6 OF 20 HCAPLUS COPYRIGHT 2002 ACS

AN 2001:446167 HCAPLUS

DN 135:47287

TI Antifogging laminated films with good prevention of water drops from staying on surface

IN Miyauchi, Tatsuo

PA· Spatta K. K., Japan

SO Jpn. Kokai Tokkyo Koho, 3 pp.

CODEN: JKXXAF

DT Patent

LA Japanese

IC ICM B32B009-00

ICS B32B015-08; C23C014-08; C23C016-06

CC 38-3 (Plastics Fabrication and Uses)

FAN.CNT 1

PΙ

PATENT NO. KIND DATE APPLICATION NO. DATE

JP 2001162715 A2 20010619 JP 1999-376399 19991209

AB The films comprise a substrate layer, a metal

layer, and a surface metal layer contg.

photocatalysts. Thus, a film having a layer of sputtered SiO2 and a top layer of sputtered alloys contg. Ag and TiO2 was manufd.

ST antifogging laminate film silver titania photocatalyst;

silica sputtering laminate film Antifogging agents IT Laminated plastic films Photolysis catalysts Sputtering (antifogging laminated films having photocatalyst-contg. sputtered metal alloy layers) Polyamides, uses ITPolyesters, uses RL: TEM (Technical or engineered material use); USES (Uses) (antifogging laminated films having photocatalyst-contg. sputtered **metal** alloy layers) ITMirrors (automotive; antifogging laminated films having photocatalyst-contg. sputtered metal alloy layers) **7631-86-9**, **Silica**, uses 215712-93-9 ITRL: TEM (Technical or engineered material use); USES (Uses) (antifogging laminated films having photocatalyst-contg. sputtered metal alloy layers) **7631-86-9**, **Silica**, uses ΙT RL: TEM (Technical or engineered material use); USES (Uses) (antifogging laminated films having photocatalyst-contg. sputtered **metal** alloy layers) 7631-86-9 HCAPLUS RN Silica (7CI, 8CI, 9CI) (CA INDEX NAME) CN o = si = 0splicant ANSWER 7 OF 20 HCAPLUS COPYRIGHT 2002 ACS L72 2001:900309 HCAPLUS AN DN 136:30435 ΤI Laminate of metal layer and insulating substrate comprised of fibrous filler and thermoplastic and thermosetting resins Ikegawa, Naoto; Kondo, Naoyuki; Nakata, Kimiaki IN Matsushita Electric Works, Ltd., Japan PAEur. Pat. Appl., 20 pp. SO CODEN: EPXXDW Patent DT. English LAICM H05K001-03 IC ICS C23C014-20 76-3 (Electric Phenomena) CC Section cross-reference(s): 38 FAN.CNT 1 PATENT NO. KIND DATE APPLICATION NO. DATE A2 EP 1162866 20011212 EP 2001-250200 20010605 PΙ R: AT, BE, CH, DE, DK, ES, FR, GB, GR, IT, LI, LU, NL, SE, MC, PT, IE, SI, LT, LV, FI, RO JP 2002060522 JP 2001-171104 A2 20020226 20010606 PRAI JP 2000-168461 20000606 A The invention relates to a laminate comprising a metal AB layer which is formed on an covers the surface of an insulating substrate activated by the plasma treatment by any method selected from a sputtering method, a vacuum depositing

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UHLIR

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method and an ion plating method. The substrate is obtained by molding a
    resin compn. contg. 20-150 parts by mass of a fibrous
     filler having an av. fiber diam. of 0.1-5 .mu.m and an
     av. fiber length of 10-50 .mu.m relative to 100 parts by mass of a base
     resin comprising a thermoplastic resin and a
     thermosetting resin.
    laminate metal layer substrate
ST
    fibrous filler thermoplastic
     thermosetting resin
    Vapor deposition process
IT
        (ion plating, metal covering; laminate of
       metal layer and insulating
       substrate comprised of fibrous filler and
        thermoplastic and thermosetting resins)
     Fillers
ΙT
      Laminated materials
    Molding
        (laminate of metal layer and
       insulating substrate comprised of fibrous
       filler and thermoplastic and thermosetting
       resins)
IT
     Fibers
    Glass fibers, processes
      Kaolin, processes
     RL: DEV (Device component use); MOA (Modifier or additive use); PEP
     (Physical, engineering or chemical process); PROC (Process); USES (Uses)
        (laminate of metal layer and
       insulating substrate comprised of fibrous
       filler and thermoplastic and thermosetting
       resins)
    Nitrile rubber, processes
IT
     Polyamides, processes
    Polysulfones, processes
     Polythiophenylenes
     RL: DEV (Device component use); PEP (Physical, engineering or chemical
    process); PROC (Process); USES (Uses)
        (laminate of metal layer and
       insulating substrate comprised of fibrous
       filler and thermoplastic and thermosetting
       resins)
IT
    Sputtering
        (metal covering; laminate of metal
       layer and insulating substrate comprised of
       fibrous filler and thermoplastic and
       thermosetting resins)
    Liquid crystals, polymeric
IT
        (polyesters; laminate of metal
       layer and insulating substrate comprised of
       fibrous filler and thermoplastic and
        thermosetting resins)
     Polyimides, processes
IT
    RL: DEV (Device component use); PEP (Physical, engineering or chemical
     process); PROC (Process); USES (Uses)
        (polyether-; laminate of metal layer and
       insulating substrate comprised of fibrous
       filler and thermoplastic and thermosetting
       resins)
    Polyethers, processes
ΙT
     RL: DEV (Device component use); PEP (Physical, engineering or chemical
     process); PROC (Process); USES (Uses)
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UHLIR
         09/871896 Page 18
        (polyimide-; laminate of metal layer and
        insulating substrate comprised of fibrous
        filler and thermoplastic and thermosetting
        resins)
     Plastics, processes
IT
     RL: DEV (Device component use); PEP (Physical, engineering or chemical
     process); PROC (Process); USES (Uses)
        (thermoplastics; laminate of metal
       layer and insulating substrate comprised of
        fibrous filler and thermoplastic and
        thermosetting resins)
    Plastics, processes
IT
     RL: DEV (Device component use); PEP (Physical, engineering or chemical
     process); PROC (Process); USES (Uses)
        (thermosetting; laminate of metal
        layer and insulating substrate comprised of
       fibrous filler and thermoplastic and
        thermosetting resins)
     11121-16-7, Aluminum borate 12047-27-7
IT
     , Barium titanate, processes 12049-50-2, Calcium
                12673-69-7, Potassium titanate
     titanate
     RL: DEV (Device component use); MOA (Modifier or additive use); PEP
     (Physical, engineering or chemical process); PROC (Process); USES (Uses)
        (laminate of metal layer and
        insulating substrate comprised of fibrous
       filler and thermoplastic and thermosetting
        resins)
IT
     13983-17-0, Wollastonite (Ca(SiO3)) 24968-12-5
     , Polybutylene terephthalate 25038-54-4, Nylon 6, processes
     25667-42-9, Poly(oxy-1,4-phenylenesulfonyl-1,4-phenylene)
     31694-16-3 32131-17-2, Nylon 66, processes
     RL: DEV (Device component use); PEP (Physical, engineering or chemical
     process); PROC (Process); USES (Uses)
        (laminate of metal layer and
        insulating substrate comprised of fibrous
       filler and thermoplastic and thermosetting
        resins)
    7440-50-8, Copper, processes
IT
     RL: DEV (Device component use); PEP (Physical, engineering or chemical
     process); PROC (Process); USES (Uses)
        (metal layer; laminate of metal
        layer and insulating substrate comprised of
       fibrous filler and thermoplastic and
        thermosetting resins)
IT
     9003-18-3
     RL: DEV (Device component use); PEP (Physical, engineering or chemical
     process); PROC (Process); USES (Uses)
        (nitrile rubber, laminate of metal layer
        and insulating substrate comprised of
       fibrous filler and thermoplastic and
        thermosetting resins)
     88-96-0, 1,2-Benzenedicarboxamide
IT
     RL: DEV (Device component use); PEP (Physical, engineering or chemical
     process); PROC (Process); USES (Uses)
        (polymer of; laminate of metal layer and
        insulating substrate comprised of fibrous
       filler and thermoplastic and thermosetting
        resins)
    7631-86-9, Silica, processes
IT
     RL: DEV (Device component use); MOA (Modifier or additive use); PEP
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*UHLIR 09/871896 Page 19
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(Physical, engineering or chemical process); PROC (Process); USES (Uses)
        (spherical filler; laminate of metal layer
       and insulating substrate comprised of
       fibrous filler and thermoplastic and
       thermosetting resins)
    11121-16-7, Aluminum borate 12047-27-7
IT
    , Barium titanate, processes 12049-50-2, Calcium
    titanate
    RL: DEV (Device component use); MOA (Modifier or additive use); PEP
     (Physical, engineering or chemical process); PROC (Process); USES (Uses)
        (laminate of metal layer and
       insulating substrate comprised of fibrous
       filler and thermoplastic and thermosetting
       resins)
    11121-16-7 HCAPLUS
RN
    Boric acid, aluminum salt (9CI) (CA INDEX NAME)
CN
*** STRUCTURE DIAGRAM IS NOT AVAILABLE ***
    12047-27-7 HCAPLUS
RN
    Barium titanium oxide (BaTiO3) (8CI, 9CI) (CA INDEX NAME)
CN
*** STRUCTURE DIAGRAM IS NOT AVAILABLE ***
    12049-50-2 HCAPLUS
RN
    Calcium titanium oxide (CaTiO3) (8CI, 9CI) (CA INDEX NAME)
CN
 Component
                     Ratio
                                       Component
                                    Registry Number
0
                                         17778-80-2
                                          7440-70-2
Ca
Тi
                                          7440-32-6
IT
    13983-17-0, Wollastonite (Ca(SiO3)) 24968-12-5
    , Polybutylene terephthalate 25038-54-4, Nylon 6, processes
    25667-42-9, Poly(oxy-1,4-phenylenesulfonyl-1,4-phenylene)
    31694-16-3 32131-17-2, Nylon 66, processes
    RL: DEV (Device component use); PEP (Physical, engineering or chemical
    process); PROC (Process); USES (Uses)
        (laminate of metal layer and
       insulating substrate comprised of fibrous
       filler and thermoplastic and thermosetting
       resins)
```

RN

CN

' Ca

RN 24968-12-5 HCAPLUS
CN Poly(oxy-1,4-butanediyloxycarbo

13983-17-0 HCAPLUS

CN Poly(oxy-1,4-butanediyloxycarbonyl-1,4-phenylenecarbonyl) (9CI) (CA INDEX NAME)

Wollastonite (Ca(SiO3)) (9CI) (CA INDEX NAME)

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RN 25038-54-4 HCAPLUS

CN Poly[imino(1-oxo-1,6-hexanediyl)] (9CI) (CA INDEX NAME)

RN 25667-42-9 HCAPLUS

CN Poly(oxy-1,4-phenylenesulfonyl-1,4-phenylene) (9CI) (CA INDEX NAME)

RN 31694-16-3 HCAPLUS

CN Poly(oxy-1,4-phenyleneoxy-1,4-phenylenecarbonyl-1,4-phenylene) (9CI) (CA INDEX NAME)

RN 32131-17-2 HCAPLUS

CN Poly[imino(1,6-dioxo-1,6-hexanediyl)imino-1,6-hexanediyl] (9CI) (CA INDEX NAME)

UHLIR 09/871896 Page 21 IT9003-18-3 RL: DEV (Device component use); PEP (Physical, engineering or chemical process); PROC (Process); USES (Uses) (nitrile rubber, laminate of metal layer and insulating substrate comprised of fibrous filler and thermoplastic and thermosetting resins) 9003-18-3 HCAPLUS RN 2-Propenenitrile, polymer with 1,3-butadiene (9CI) (CA INDEX NAME) CN 1 CM CRN 107-13-1 CMF C3 H3 N $H_2C = CH - C = N$ CM 2 CRN 106-99-0 CMF C4 H6 H₂C== CH- CH== CH₂ 7631-86-9, Silica, processes ITRL: DEV (Device component use); MOA (Modifier or additive use); PEP (Physical, engineering or chemical process); PROC (Process); USES (Uses) (spherical filler; laminate of metal layer and insulating substrate comprised of fibrous filler and thermoplastic and thermosetting resins) 7631-86-9 HCAPLUS RNSilica (7CI, 8CI, 9CI) (CA INDEX NAME) CN 0 = si = 0L72 ANSWER 8 OF 20 WPIX COPYRIGHT 2002 DERWENT INFORMATION LTD 2001-451730 [48] ΑN WPIX DNC C2001-136437 DNN N2001-334409 TIRedirecting chemical vapor deposition of material to produce coatings on substrate, involves selectively changing localized environment of energy source to redirect gases by applying source of pressure differential. A17 A23 A85 L03 P42 P73 V02 V06 X11 X12 DC DALZELL, W J; DESHPANDE, G; HENDRICK, M; HUNT, A T; HWANG, J T; LAYE, N S; IN OLJACA, M; PODA, A; SHANMUGHAM, S; SHOUP, S S; TOMOV, T (MICR-N) MICROCOATING TECHNOLOGIES INC PACYC 94 WO 2001047704 A1 20010705 (200148)* EN PΙ B32B005-16 46p RW: AT BE CH CY DE DK EA ES FI FR GB GH GM GR IE IT KE LS LU MC MW MZ NL OA PT SD SE SL SZ TR TZ UG ZW W: AE AG AL AM AT AU AZ BA BB BG BR BY BZ CA CH CN CR CU CZ DE DK DM DZ EE ES FI GB GD GE GH GM HR HU ID IL IN IS JP KE KG KP KR KZ LC

LK LR LS LT LU LV MA MD MG MK MN MW MX MZ NO NZ PL PT RO RU SD SE SG SI SK SL TJ TM TR TT TZ UA UG US UZ VN YU ZA ZW

AU 2001027402 A 20010709 (200164)

B32B005-16

ADT WO 2001047704 A1 WO 2000-US35416 20001221; AU 2001027402 A AU 2001-27402 20001221

FDT AU 2001027402 A Based on WO 200147704

PRAI US 2000-234575P 20000922; US 1999-474491 19991229

IC ICM B32B005-16

ICS B05B007-00; B05B007-16; B05D001-08; B05D001-36; B32B005-00; B32B009-00; B32B009-04; B32B013-12; B32B015-08; B32B027-00;

B32B027-08; B32B027-36; C23C004-04; C23C004-08; C23C004-10

AB WO 200147704 A UPAB: 20010829

NOVELTY - Energy source activates precursor introduced into localized environment, within gases which are directed along path (I). At least one source of pressure differential is applied to localized environment of energy source, such that localized environment is selectively changed to redirect gases from path (I) to redirected path (II). Gases are contacted to substrate surface to form at least part of material.

DETAILED DESCRIPTION - Precursor is introduced into localized environment of at least one energy source. Energy source activates precursor within gases which are directed along path (I). At least one source of pressure differential is applied to localized environment of energy source, such that localized environment is selectively changed to redirect gases from path (I) to redirected path (II). Thereby, gases are made to contact surface and form at least part of material.

INDEPENDENT CLAIMS are also included for the following:

- (i) Apparatus for chemical vapor deposition of material, comprises a nozzle for directing a precursor material along a path (I), an ignition mechanism for igniting the precursor material and for vaporizing at least a portion of the precursor material, and a redirecting jet for creating a pressure differential along the path (I) to redirect the partially vaporized material from path (I) to redirected path (II). The partially vaporized material is made to contact a surface to form the material;
- (ii) Insulator for an electrical conductor or superconductor which consists of thin film coating of at least one electrically insulating oxide;
- (iii) Insulated electrical conductor or superconductor which comprises electrical insulator; and
- (iv) A laminate which comprises a polymer-containing material coated with a combustion, chemical vapor-deposited or redirected chemical deposited barrier layer. Barrier layer is coating of metal, an oxide or a mixture of metal and oxide, that inhibits gas and vapor transmission and/or provides a scratch resistant surface.

USE - For chemical vapor deposition to form powders and coatings on substrate, and for production of barrier or electrochemical coatings on polymers, as well as protective or insulating coating for metal foil and electromechanical windings. The chemical vapor deposition method is used for forming thin film insulating oxide coatings on the surface of conductive or super conductive wires. The redirecting methods are also useful for producing powders that can be collected for further processing and for forming metal oxide barrier coatings for polymeric food and beverage containers.

ADVANTAGE - A uniform coating is obtained by chemical vapor deposition method by redirecting the energy source and/or hot gases, thereby produced. The energy source and/or active deposition gases are activated, redirected and redistributed to control the material properties, decrease the gas temperature or increase the substrate area coated by the deposition material. By directing the deposition gases, vapor clusters and particles in a direction different from heat produced

by energy source, it is possible to control the substrate temperature to allow deposition without damaging the substrate. A more effective distribution of deposition species in the gases is enabled. At the same time, precursor are allowed to attain the appropriate temperatures for forming the coating composition, while avoiding over heating and damaging the substrate. The amount of heat transferred to the substrate is reduced. The redirected gases are more thoroughly mixed and therefore provide a more homogeneous coating and heat distribution on substrate. The efficiency of the electromagnetic device is increased since the thickness of insulators on the windings of the device is reduced and insulation between adjacent windings and other components is increased. Thin film layers with excellent adhesion are obtained. Dwg.0/11 CPI EPI GMPI AB CPI: A99-A; L03-A01B3; L03-A01C EPI: V02-H01B; V06-M11B; X11-J08B; X12-C01D2; X12-D06A; X12-D06A1; X12-D07B9; X12-E02B COPYRIGHT 2002 DERWENT INFORMATION LTD 2001-488488 [53] WPIX DNC C2001-146549

L72 ANSWER 9 OF 20 WPIX

AN

DNN N2001-361478

Electrochemical capacitor, for military and commercial applications, TIcomprises polymer electrolyte including solid base polymer material in form of thin polymer, such as polyester, polypropylene.

A85 L03 M11 V01 X16 DC

MUNSHI, M Z A IN

PΑ (LITH-N) LITHIUM POWER TECHNOLOGIES INC

CYC 93

FS FA

MC

WO 2001039305 A1 20010531 (200153) * EN 45p PΙ H01M006-18

> RW: AT BE CH CY DE DK EA ES FI FR GB GH GM GR IE IT KE LS LU MC MW MZ NL OA PT SD SE SL SZ TR TZ UG ZW

W: AE AG AL AM AT AU AZ BA BB BG BR BY BZ CA CH CN CR CU CZ DE DK DM DZ EE ES FI GB GD GE GH GM HR HU ID IL IN IS JP KE KG KP KR KZ LC LK LR LS LT LU LV MD MG MK MN MW MX MZ NO NZ PL PT RO RU SD SE SG SI SK SL TJ TM TR TT TZ UA UG US UZ VN YU ZA ZW

AU 2001022512 A 20010604 (200153) H01M006-18

WO 2001039305 A1 WO 2000-US32275 20001122; AU 2001022512 A AU 2001-22512 20001122

AU 2001022512 A Based on WO 200139305

19991125 PRAI US 1999-449443

ICICM H01M006-18

WO 200139305 A UPAB: 20010919 AΒ

NOVELTY - The electrochemical capacitor comprises a polymer electrolyte including solid base polymer material in the form of thin polymer, such as polyester (PET), polypropylene (PP), polyethylene naphthalate (PEN), polycarbonate (PC), polyphenylene sulfide (PPS), polyvinylidene-fluoride (PVDF), polytetrafluoroethylene (PTFE) or their mixtures.

DETAILED DESCRIPTION - INDEPENDENT CLAIMS are also included for;

- (1) Manufacture of polymer electrolyte for electrochemical capacitor, which involves dissolving PVDF and acrylate monomer or oligomer in a hydrocarbon solvent to form polymer solution, casting the polymer solution into thin film by evaporating hydrocarbon solvent, soaking the thin film in a predetermined liquid electrolyte solution containing salt, and curing acrylate monomer or oligomer;
- (2) Manufacture of dimensionally stable, highly resilient polymer solid-solution blend film for electrochemical capacitor which involves mixing PVDF and AMPS homogeneously to form a copolymer blend. A very high surface area inorganic filler having average particle size diameter of

- less than 0.05 micro m, surface area of 100 m2/g and concentration of 0.1--30 weight% is dispersed in the copolymer blend. The obtained mixture is cast into a thin film. Subsequently, the thin film is soaked in a liquid solvent electrolyte for absorption and retention of electrolyte in the thin film. The porosity and mechanical stability of the thin film are enhanced by the presence of inorganic filler;
- (3) Thin film electrochemical capacitor comprising (a) resilient flexible polymeric electrolyte thin film including base polymer dispersed with inorganic filler to increase its surface area and porosity, (b) liquid electrolyte comprising liquid polymer, (c) organic solvent electrolyte and salt solution impregnated in thin film, and (d) a pair of spaced-apart flexible thin film electrodes. Each electrodes are adhered to a current connector, and the thin film is tightly sandwiched between the electrodes;
- (4) An electrochemical capacitor electrode comprising ultra thin film metal substrate (which is etched to increase its intrinsic surface area) for cathode or anode substrate of electrochemical capacitor. The ultra thin film metal substrate has thickness of 1-10 micro m and comprises metallic material selected from aluminum, copper, nickel, titanium, stainless steel and alloy including inconel;
- (5) Method for coating ultra thin film metallized polymer substrate for thin film electrochemical capacitor with thin film active anode and cathode materials. Anode and cathode materials are prepared to a size suitable for application to thin film metallized polymer substrate. The prepared materials are then applied directly to either sides of thin film metallized polymer substrate to form thin film of anode and cathode materials of desired thickness;
- (6) Fabrication of thin film electrochemical capacitor which involves forming thin film electrode by double **metallizing** polymer substrate for applying activated electrode material, and **laminating** separate anode and cathode elements respectively on either sides of double-**metallized** polymer substrate to provide a highly flexible electrode for capacitor;
- (7) Bipolar electrode for capacitor, comprising flexible polymer substrate of 0.5-50 micro m thickness, two metallization layers of 1 micro m thickness formed on each side of substrate, and an ultra-thin anode layer formed over metallization layer. The ratio of substrate thickness to anode or cathode layer thickness is less than 0.5, and surface resistivity for each anode and cathode layer is less than 0.1 ohm/square;
- (8) Formation of thin bipolar capacitor which involves laminating together layer(s) of bipolar unit between a layer of anode and cathode to provide a stack having laminar ends. The anode and cathode comprises a metallized polymer current collectors. The anode and cathode are oriented and current collectors are applied to laminar ends. The bipolar unit comprises a flexible polymer substrate of 0.5-50 micro m thickness optionally dispersed with electrically conductive material, two metallization layers of 1 micro m thickness formed on either sides of polymer substrate, ultra-thin anode and cathode layers sequentially formed over metallization layer and layer of solid polymer electrolyte formed over anode or cathode layer.

USE - For military and commercial applications.

ADVANTAGE - Electrochemical capacitors with ultra-thin current collectors having improved energy density, power density, higher capacity utilization, higher cycle life, greater charge-discharge efficiencies, lower ESR, greater safety and greater reliability, is produced economically at high speed. The capacitor has a base polymer material that

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is dimensionally stable in aqueous or non-aqueous solvents and
    temperature, and exhibits little or no swelling characteristics when
     contact with liquid solvents.
     Dwg.0/4
    CPI EPI
FS
FΑ
    AΒ
    CPI: A12-E07B; L03-B03A; M11-B05
MC
    EPI: V01-B01A; V01-B01B1; V01-B01D; V01-B01G; X16-E01C; X16-J01A; X16-L02
L72 ANSWER 10 OF 20 HCAPLUS COPYRIGHT 2002 ACS
AN
    2000:344299 HCAPLUS
DN 132:335635
    Laminated microporous polyester films with excellent
TI
    thermal insulating properties and metal cans
    laminated therewith
    Hibiya, Takashi; Miki, Takatoshi
IN
    Mitsubishi Chemical Polyester Film Co., Ltd., Japan
PA
    Jpn. Kokai Tokkyo Koho, 9 pp.
SO
    CODEN: JKXXAF
    Patent
\mathsf{DT}
LA
     Japanese
IC
    ICM B32B027-36
     ICS B32B005-18; B32B007-02; B32B015-08; B65D001-12; C08J005-18;
         C08J009-00; B29C055-12; B29K067-00; B29K105-04; B29K105-06;
         B29L009-00; C08L067-02
    38-3 (Plastics Fabrication and Uses)
CC
FAN.CNT 1
     PATENT NO.
                      KIND
                            DATE
                                           APPLICATION NO. DATE
                                           JP 1998-320292
    JP 2000141569
                     A2
                            20000523
PΙ
                                                            19981111
    The films with heat shrinkage .gtoreq.2.0% at 110.degree. have (A)
AB
    microporous polyester layers with d. 0.50-1.00 g/cm3 and (B)
    polyester layers with d. .gtoreq.1.10 g/cm3 on at least one side
    of A. Thus, a biaxially oriented 3-layer film comprising a 13% cryst.
    polypropylene-contg. PET middle layer and 0.12% SiO2
     -contg. PET surface layers showed 60.degree. gloss 99%,
     20.degree. gloss 44%, and smooth surface after lamination on a
    metal can.
ST
    polyester multilayer film metal can laminate
     ; thermal insulator microporous PET polypropylene
    blend; heat shrinkage PET silica film lamination
IT
    Heat-shrinkable films
      Laminated plastic films
     Thermal insulators
        (laminated microporous polyester films for
       metal cans with good thermal insulating properties)
IT
    Polyesters, uses
    RL: POF (Polymer in formulation); PRP (Properties); TEM (Technical or
     engineered material use); USES (Uses)
        (laminated microporous polyester films for
       metal cans with good thermal insulating properties)
     7631-86-9, Silica, uses 9003-07-0, Polypropylene
ΙT
    13463-67-7, Titanium oxide, uses
     RL: MOA (Modifier or additive use); USES (Uses)
        (laminated microporous polyester films for
       metal cans with good thermal insulating properties)
    25038-59-9, Poly(ethylene terephthalate), uses
IT
     RL: POF (Polymer in formulation); PRP (Properties); TEM (Technical or
     engineered material use); USES (Uses)
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(laminated microporous polyester films for metal cans with good thermal insulating properties)

7631-86-9, Silica, uses
RL: MOA (Modifier or additive use); USES (Uses)
(laminated microporous polyester films for metal cans with good thermal insulating properties)

RN 7631-86-9 HCAPLUS
CN Silica (7CI, 8CI, 9CI) (CA INDEX NAME)

0== Si== 0

L72 ANSWER 11 OF 20 HCAPLUS COPYRIGHT 2002 ACS ΑN 2000:105106 HCAPLUS 132:138533 DN Gas-barrier transparent laminates with good adhesion, packaging materials, TIand their packaged products Sasaki, Noboru; Sekiguchi, Mamoru; Hayashi, Kenji; Komori, Tsunenori; ΙN Matsuo, Ryukichi Toppan Printing Co., Ltd., Japan PAJpn. Kokai Tokkyo Koho, 10 pp. SO CODEN: JKXXAF Patent DTJapanese LAICM B32B009-00 IC ICS B32B007-02; B32B027-40; B65D065-40 CC 38-3 (Plastics Fabrication and Uses) Section cross-reference(s): 17, 63, 67 FAN.CNT 1 PATENT NO. KIND DATE APPLICATION NO. DATE JP 2000043182 A2 20000215 JP 1998-218226 19980731 PIThe laminates, useful for packaging materials and bags for AB foods, pharmaceuticals, etc., consist of transparent plastic substrates, transparent primer layers comprising composites from

organosilanes R'Si(OR)3 (R' = alkyl, vinyl, glycidoxypropyl, etc.; R =

CnH2n+1 alkyl; n .gtoreq.1) or their hydrolyzates, acrylic polyols, and

isocyanates on .gtoreq.1 side of the substrates, 5-300 nm-thick vapor-deposited thin film layers of inorg. oxides, and gas-barrier composite films contg. water-sol. polymers, inorg. layered compds., and metal alkoxides M(OR)n (M = metal; R = CnH2n+1 alkyl; n .gtoreq.1), where the interlayer spacing of the layered compds. in the composite films is .gtoreq.1.2 times that of the compds. before film formation. Thus, a transparent laminate of a PET substrate, a primer layer contg. composites prepd. from Si(OEt)4, epoxycyclohexylethyltrimethoxysilane, an acrylic polyol, and TDI in the presence of SnCl2, a .apprx.20 nm-thick vapor-deposited Al2O3 layer, and a gas-barrier layer (interlayer spacing enlargement ratio 2.17) contg. a 35:3:62 mixt. of montmorillonite, poly(vinyl alc.), and Si(OEt)4 showed O permeability 0.2 mL/m2-day and high lamination strength after retort sterilization at 125.degree. for 30 min.

ST transparent laminated film packaging acrylic siloxane; oxide layered compd gas barrier packaging; polyvinyl alc montmorillonite silane packaging film Polyurethanes, uses

RL: FFD (Food or feed use); PRP (Properties); TEM (Technical or engineered material use); BIOL (Biological study); USES (Uses)

(acrylic-polysiloxane-; delamination- and retort-resistant transparent laminated packaging films having polymer-montmorillonite composite gas-barrier layers)

IT Polysiloxanes, uses

RL: FFD (Food or feed use); PRP (Properties); TEM (Technical or engineered material use); BIOL (Biological study); USES (Uses)

(acrylic-polyurethane-; delamination- and retort-resistant transparent laminated packaging films having polymer-montmorillonite composite gas-barrier layers)

IT Silanes

RL: FFD (Food or feed use); PRP (Properties); TEM (Technical or engineered material use); BIOL (Biological study); USES (Uses)

(alkoxy; delamination- and retort-resistant transparent laminated packaging films having polymer-montmorillonite composite gas-barrier layers)

IT Metal alkoxides

RL: FFD (Food or feed use); PRP (Properties); TEM (Technical or engineered material use); BIOL (Biological study); USES (Uses)

(composites with montmorillonite; delamination- and retort-resistant transparent laminated packaging films having polymer-montmorillonite composite gas-barrier layers)

IT Bags

Food packaging materials

Laminated plastic films

Polymerization catalysts

(delamination- and retort-resistant transparent laminated packaging films having polymer-montmorillonite composite gas-barrier layers)

IT Intercalation compounds

Oxides (inorganic), uses

RL: FFD (Food or feed use); PRP (Properties); TEM (Technical or engineered material use); BIOL (Biological study); USES (Uses)

(delamination- and retort-resistant transparent laminated packaging films having polymer-montmorillonite composite gas-barrier layers)

IT Packaging materials

(films, gas-impermeable, transparent; delamination- and retort-resistant transparent laminated packaging films having polymer-montmorillonite composite gas-barrier layers)

IT Packaging materials

(films, heat-sealable, multilayer; delamination- and retort-resistant transparent laminated packaging films having polymer-montmorillonite composite gas-barrier layers)

```
Smectite group minerals
IT
     RL: PRP (Properties); TEM (Technical or engineered material use); USES
     (Uses)
        (intercalation complexes; delamination- and retort-resistant
       transparent laminated packaging films having polymer-montmorillonite
        composite gas-barrier layers)
    Acrylic polymers, uses
IT
    RL: FFD (Food or feed use); PRP (Properties); TEM (Technical or engineered
    material use); BIOL (Biological study); USES (Uses)
        (polyurethane-siloxane-; delamination- and retort-resistant transparent
       laminated packaging films having polymer-montmorillonite composite
       gas-barrier layers)
    Packaging materials
IT
        (retort pouches; delamination- and retort-resistant transparent
       laminated packaging films having polymer-montmorillonite composite
       gas-barrier layers)
    Polyesters, uses
IT
    RL: FFD (Food or feed use); PRP (Properties); TEM (Technical or engineered
    material use); BIOL (Biological study); USES (Uses)
        (substrate; delamination- and retort-resistant transparent laminated
       packaging films having polymer-montmorillonite composite gas-barrier
       layers)
IT
    Polymers, uses
    RL: FFD (Food or feed use); PRP (Properties); TEM (Technical or engineered
    material use); BIOL (Biological study); USES (Uses)
        (water-sol., composites with montmorillonite; delamination- and
       retort-resistant transparent laminated packaging films having
       polymer-montmorillonite composite gas-barrier layers)
    7440-31-5D, Tin, alkoxides 7772-99-8, Tin chloride, uses
IT
                                                                  57572-63-1,
    Tin oxychloride
    RL: CAT (Catalyst use); USES (Uses)
        (catalyst in primer layers; delamination- and retort-resistant
       transparent laminated packaging films having polymer-montmorillonite
       composite gas-barrier layers)
    78-10-4DP, Tetraethoxysilane, polymers with epoxycyclohexylethyltrimethoxy
IT
    silane, acrylic polyol, and TDI 1318-93-0DP, Montmorillonite,
    intercalation complexes with poly(vinyl alc.) and Et silicate
     3388-04-3DP, Epoxycyclohexylethyltrimethoxysilane, polymers with acrylic
                     9002-89-5DP, Poly(vinyl alcohol), intercalation complexes
    polyol and TDI
    with montmorillonite and Et silicate 11099-06-2DP, Tetraethoxysilane
    homopolymer, intercalation complexes with montmorillonite and poly(vinyl
            26471-62-5DP, TDI, polymers with alkoxysilanes and acrylic polyol
    RL: FFD (Food or feed use); IMF (Industrial manufacture); PRP
     (Properties); TEM (Technical or engineered material use); BIOL (Biological
     study); PREP (Preparation); USES (Uses)
        (delamination- and retort-resistant transparent laminated packaging
       films having polymer-montmorillonite composite gas-barrier layers)
    1344-28-1, Aluminum oxide, uses 7631-86-9, Silicon oxide, uses
IT
    RL: FFD (Food or feed use); PRP (Properties); TEM (Technical or engineered
    material use); BIOL (Biological study); USES (Uses)
        (delamination- and retort-resistant transparent laminated packaging
       films having polymer-montmorillonite composite gas-barrier layers)
    555-31-7D, Triisopropoxyaluminum, intercalation complexes
IT
    Magnesia, uses 7429-90-5D, Aluminum, alkoxides, intercalation complexes
    7440-21-3D, Silicon, alkoxides, intercalation complexes
                                                               7440-32-6D,
    Titanium, alkoxides, intercalation complexes
                                                  7440-67-7D,
     Zirconium, alkoxides, intercalation complexes
    RL: PRP (Properties); TEM (Technical or engineered material use); USES
     (Uses)
        (delamination- and retort-resistant transparent laminated packaging
```

UHLIR 09/871896 Page 29

films having polymer-montmorillonite composite gas-barrier layers)

IT **25038-59-9**, **PET** (**polyester**), uses

RL: FFD (Food or feed use); PRP (Properties); TEM (Technical or engineered material use); BIOL (Biological study); USES (Uses)

(substrate; delamination- and retort-resistant transparent laminated packaging films having polymer-montmorillonite composite gas-barrier layers)

IT 7631-86-9, Silicon oxide, uses

RL: FFD (Food or feed use); PRP (Properties); TEM (Technical or engineered material use); BIOL (Biological study); USES (Uses)

(delamination- and retort-resistant transparent laminated packaging films having polymer-montmorillonite composite gas-barrier layers)

RN 7631-86-9 HCAPLUS

CN Silica (7CI, 8CI, 9CI) (CA INDEX NAME)

o== si== o

IT 25038-59-9, PET (polyester), uses

RL: FFD (Food or feed use); PRP (Properties); TEM (Technical or engineered material use); BIOL (Biological study); USES (Uses)

(substrate; delamination- and retort-resistant transparent laminated packaging films having polymer-montmorillonite composite gas-barrier layers)

RN 25038-59-9 HCAPLUS

CN Poly(oxy-1,2-ethanediyloxycarbonyl-1,4-phenylenecarbonyl) (9CI) (CA INDEX NAME)

$$\begin{bmatrix} O \\ C-O-CH_2-CH_2-O \\ ---- \end{bmatrix}$$

L72 ANSWER 12 OF 20 HCAPLUS COPYRIGHT 2002 ACS

AN 2000:23462 HCAPLUS

DN 132:65192

TI Transparent laminated film with good strength, dimensional stability, and electromagnetic shielding effect

IN Nishiyama, Kiminori

PA Teijin Ltd., Japan

SO Jpn. Kokai Tokkyo Koho, 6 pp.

CODEN: JKXXAF

DT Patent

LA Japanese

IC ICM B32B007-02

ICS B32B009-00; B32B015-04

CC 38-3 (Plastics Fabrication and Uses)

Section cross-reference(s): 74

FAN.CNT 1

PATENT NO. KIND DATE APPLICATION NO. DATE

```
JP 2000006291
                       A2
                            20000111
ΡI
                                           JP 1998-175738
                                                             19980623
     The film esp. useful for CRT and LCD comprises a transparent thermoplastic
AB
     film and a laminated layer consisting of metal and
     dielec. substance, where the thermoplastic film has glass temp.
     .gtoreq.100.degree., the film, on the laminated side, has middle
     line av. surface roughness (Ra) .ltoreq.50 nm, 10 point av. roughness (Rz)
     .ltoreq.500 nm, and the resulting laminated film has visible
     light transmittance (Tvis) .gtoreq.60% and selective transmittance
     (Tvis/(Tvis + Tnir) \times 100).gtoreq.80%, Tnir = near IR transmittance.
     Vacuum sputtering sequentially a 30-nm In2O3, a 15-nm Ag layer, and a
     30-nm In2O3 on a 50-.mu.m biaxially oriented poly(ethylene
     2,6-naphthalate) film with Ra 7 nm and Rz 120 nm and bonding to a glass
     plate via an adhesive gave a laminated film with breaking strength 55
     kg/mm2, surface resistivity 6.8 .OMEGA./.box., and good visible light
     transmittance and selective transmittance.
     laminated film strength dimensional stability electromagnetic shield; CRT
ST
     LCD laminated film electromagnetic shield
IT
     Electric insulators
     Electromagnetic shields
     Laminated plastic films
        (transparent laminated film with good strength, dimensional stability,
        and electromagnetic shielding effect)
\operatorname{IT}
     Polyesters, uses
     RL: PRP (Properties); TEM (Technical or engineered material use); USES
     (Uses)
        (transparent laminated film with good strength, dimensional stability,
        and electromagnetic shielding effect)
     1312-43-2, Indium trioxide 1314-13-2, Zinc oxide, uses
\operatorname{IT}
                                                                 1314-23-4,
     Zirconium dioxide, uses 1314-61-0, Tantalum pentoxide
                                                                7440-22-4,
     Silver, uses 7440-50-8, Copper, uses
                                             7440-57-5, Gold, uses
     7631-86-9, Silicon dioxide, uses 13463-67-7,
     Titanium dioxide, uses
                              18282-10-5, Tin dioxide
    Poly(ethylene 2,6-naphthalate) 25230-87-9, Poly(ethylene
     2,6-naphthalate) 113443-18-8, Silicon monooxide
   RL: PRP (Properties); TEM (Technical or engineered material use); USES
     (Uses)
        (transparent laminated film with good strength, dimensional stability,
        and electromagnetic shielding effect)
     7631-86-9, Silicon dioxide, uses
IT
     RL: PRP (Properties); TEM (Technical or engineered material use); USES
     (Uses)
        (transparent laminated film with good strength, dimensional stability,
        and electromagnetic shielding effect)
     7631-86-9 HCAPLUS
RN
     Silica (7CI, 8CI, 9CI) (CA INDEX NAME)
CN
o = si = o
    ANSWER 13 OF 20 HCAPLUS COPYRIGHT 2002 ACS
L72
    1999:757007 HCAPLUS
AN
DN
     132:8303
TI
    Transparent multilayer electromagnetic wave reflection preventive
     components and reflection prevention thereof
     Nagano, Toshiaki; Maki, Tetsu
IN
```

Kansai Paint Co., Ltd., Japan

Jpn. Kokai Tokkyo Koho, 8 pp.

CODEN: JKXXAF

PA

SO

and radio wave acid resisting method of possessing transparency)

Polyesters, properties RL: DEV (Device component use); NUU (Other use, unclassified); PRP (Properties); USES (Uses)

(support plate, transparent; laminate type radio wave acid resisting body and radio wave acid resisting method of possessing transparency)

IT

IT 7631-86-9, Silica, uses 12047-27-7, Barium titanate, uses

RL: MOA (Modifier or additive use); USES (Uses)

(powder; laminate type radio wave acid resisting body and radio wave acid resisting method of possessing transparency)

IT 25038-59-9, Polyethylene terephthalate,

properties

RL: DEV (Device component use); NUU (Other use, unclassified); PRP (Properties); USES (Uses)

(support plate, transparent; laminate type radio wave acid resisting body and radio wave acid resisting method of possessing transparency) 50926-11-9, ITO

(transparent; laminate type radio wave acid resisting body and radio wave acid resisting method of possessing transparency)

IT 7631-86-9, Silica, uses 12047-27-7, Barium

titanate, uses

RL: MOA (Modifier or additive use); USES (Uses)

(powder; laminate type radio wave acid resisting body and radio wave acid resisting method of possessing transparency)

RN 7631-86-9 HCAPLUS

CN Silica (7CI, 8CI, 9CI) (CA INDEX NAME)

o = si = o

RN 12047-27-7 HCAPLUS

CN Barium titanium oxide (BaTiO3) (8CI, 9CI) (CA INDEX NAME)

*** STRUCTURE DIAGRAM IS NOT AVAILABLE ***

IT 25038-59-9, Polyethylene terephthalate,

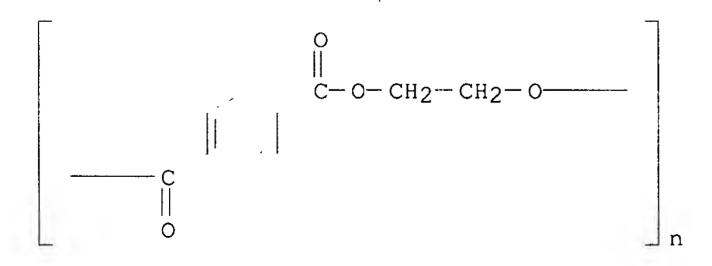
properties

RL: DEV (Device component use); NUU (Other use, unclassified); PRP (Properties); USES (Uses)

(support plate, transparent; laminate type radio wave acid resisting body and radio wave acid resisting method of possessing transparency)

RN 25038-59-9 HCAPLUS

CN Poly(oxy-1,2-ethanediyloxycarbonyl-1,4-phenylenecarbonyl) (9CI) (CA INDEX NAME)



L72 ANSWER 14 OF 20 HCAPLUS COPYRIGHT 2002 ACS

AN 1999:463716 HCAPLUS

DN 131:103475

TI Heat-reflective thermally insulating sheets of laminates of thermoplastic polymer-coated sheets with metals

```
Monden, Toshiaki; Seki, Masao
ΙN
    Toray Industries, Inc., Japan
PA
     Jpn. Kokai Tokkyo Koho, 4 pp.
SO
    CODEN: JKXXAF
    Patent ·
\mathsf{DT}
LA
     Japanese
IC
     ICM D06M011-46
     ICS B60J007-10; B65D081-38; B65G003-02; D06M011-45; D06M011-83;
         F16L059-08; D06M015-248; D06M017-00
    40-5 (Textiles and Fibers)
CC
    Section cross-reference(s): 17, 38
FAN.CNT 1
     PATENT NO.
                                           APPLICATION NO.
                     KIND
                            DATE
                                                            DATE
     _____
                            19990727
    JP 11200240 A2
                                           JP 1998-2153
                                                            19980108
PI
    The heat-insulative sheets comprise sheets coated with
AB
    thermoplastic polymer compns. optionally contq. compds. exhibiting radio
    wave reflection amt. .gtoreq.50% and have one or two sides of the sheets
    laminated with a layer comprising metals and optionally
    having radio wave reflection amt. .gtoreq.50%. The sheets are useful for
     storage or transportation of beer, juices, and wine with good temp.
    retention. A woven sail cloth of polyester fibers was coated
    with a compn. contg. PVC 100, dioctyl phthalate 60, stabilizer 5, CaCO3
    10, and laminated with Al foil using an adhesive to give a heat-
     insulating sheet exhibiting change of temp. of H2O in a juice can
     1.9.degree./6 h on filling the can with H2O at 25.degree., covering the
    can with the sheet, and exposing the can to sunlight with av. temp.
     35.degree..
ST
    polyester fabric PVC aluminum laminate heat insulative
     ; fabric thermoplastic metal laminate heat
     insulative; juice transportation heat insulative sheet;
    wine transportation heat insulative sheet; beer transportation
    heat insulative sheet
    Polvesters, uses
IT
    RL: PEP (Physical, engineering or chemical process); PRP (Properties); TEM
     (Technical or engineered material use); PROC (Process); USES (Uses)
        (coatings; heat-reflective thermally insulating sheets of
       laminates of thermoplastic polymer-coated sheets with
       metals)
    Laminated materials
IT
    Textiles
    Thermal insulators
        (heat-reflective thermally insulating sheets of
       laminates of thermoplastic polymer-coated sheets with
       metals)
    Polyester fibers, uses
IT
    RL: PEP (Physical, engineering or chemical process); PRP (Properties); TEM
     (Technical or engineered material use); PROC (Process); USES (Uses)
        (heat-reflective thermally insulating sheets of
       laminates of thermoplastic polymer-coated sheets with
       metals)
    Metals, uses
IT
    RL: PRP (Properties); TEM (Technical or engineered material use); USES
     (Uses)
        (heat-reflective thermally insulating sheets of
       laminates of thermoplastic polymer-coated sheets with
       metals)
IT
    Beer
    Fruit and vegetable juices
     Wine
```

UHLIR

09/871896 Page 33

```
UHLIR
           09/871896 Page 34
         (storage or transportation of; heat-reflective thermally
         insulating sheets of laminates of thermoplastic
         polymer-coated sheets with metals for)
      Plastics, uses
 IT
      RL: PEP (Physical, engineering or chemical process); PRP (Properties); TEM
      (Technical or engineered material use); PROC (Process); USES (Uses)
         (thermoplastics, coatings; heat-reflective thermally insulating
         sheets of laminates of thermoplastic polymer-coated sheets
         with metals)
 IT 1314-13-2, Zinc oxide, uses 7631-86-9, Silicon oxide, uses
      RL: MOA (Modifier or additive use); USES (Uses)
         (additive; heat-reflective thermally insulating sheets of
         laminates of thermoplastic polymer-coated sheets with
         metals)
     13463-67-7, Titanium oxide, uses
 IT
      RL: MOA (Modifier or additive use); PRP (Properties); USES (Uses)
         (additive; heat-reflective thermally insulating sheets of
         laminates of thermoplastic polymer-coated sheets with
         metals)
      9002-86-2, PVC
 IT
                       9002-88-4, Polyethylene
                                                 9003-07-0, Polypropylene
     .24937-78-8, Ethylene-vinyl acetate copolymer
      RL: PEP (Physical, engineering or chemical process); PRP (Properties); TEM
      (Technical or engineered material use); PROC (Process); USES (Uses)
         (coating; heat-reflective thermally insulating sheets of
         laminates of thermoplastic polymer-coated sheets with
         metals)
 IT
      7429-90-5, Aluminum, uses
     RL: PRP (Properties); TEM (Technical or engineered material use); USES
      (Uses)
         (laminates with PVC-coated polyester fabrics;
         heat-reflective thermally insulating sheets of
         laminates of thermoplastic polymer-coated sheets with
         metals)
     7631-86-9, Silicon oxide, uses
 IT
     RL: MOA (Modifier or additive use); USES (Uses)
         (additive; heat-reflective thermally insulating sheets of
         laminates of thermoplastic polymer-coated sheets with
         metals)
      7631-86-9 HCAPLUS
 RN
     Silica (7CI, 8CI, 9CI) (CA INDEX NAME)
 CN
o== si== o
L72 ANSWER 15 OF 20 HCAPLUS COPYRIGHT 2002 ACS
     1995:849648 HCAPLUS
AN
 DN
     123:342818
     Sheet materials contg. metallic coating layers with interference colors
 {
m TI}
     Okumura, Haruichiro; Negishi, Takao
 IN
     Toray Industries, Japan
 PA
 SO
     Jpn. Kokai Tokkyo Koho, 8 pp.
     CODEN: JKXXAF
     Patent
 DT
     Japanese
LA
 IC
     ICM D06M011-83
     ICS B32B007-02; B32B009-00; B32B015-04; D06Q001-04
 ICI
     D06M101-32
 CC
     38-3 (Plastics Fabrication and Uses)
```

Section cross-reference(s): 40 FAN.CNT 1 PATENT NO. KIND DATE APPLICATION NO. DATE JP 07189122 A2 19950725 JP 1993-335130 PΙ 19931228 JP 3198768 20010813 B2 The title sheets with interference colors comprise sheet AB substrates, successively laminated with (A) reflective metal films composed of .gtoreq.1 metals selected from Ti, Ni, Co, and Pt, (B) transparent metal layers, and (C) translucent metal films. Thus, PET fabric was vapor deposited with Ti, SiO, and Cr successively, heated at 170.degree. for 2 min, coated with di-Me polysiloxane, and heated at 130.degree. for 2 min to give an iridescent test piece. interference color sheet metal layer STΙT Films (sheet materials with iridescent interference color with reflective metal layers, transparent metal layers, and translucent metal layers) Polyester fibers, uses IT RL: PEP (Physical, engineering or chemical process); PRP (Properties); TEM (Technical or engineered material use); PROC (Process); USES (Uses) (substrates; sheet materials with iridescent interference color with reflective metal layers, transparent metal layers, and translucent metal layers) 1312-43-2, Indium oxide (In2O3) 1344-28-1, Aluminum oxide (Al2O3), uses IT7429-90-5, Aluminum, uses 7440-02-0, Nickel, uses 7440-06-4, Platinum, 7440-21-3, Silicon, uses 7440-22-4, Silver, uses 7440-32-6, uses Titanium, uses 7440-47-3, Chromium, uses 7440-48-4, Cobalt, 7440-57-5, Gold, uses **7631-86-9**, **Silicon** dioxide, uses 7783-40-6, Magnesium fluoride (MgF2) 12137-20-1, Titanium monoxide 13463-67-7, Titanium dioxide, uses 18282-10-5, Tin oxide (SnO2) 50926-11-9, ITO 113443-18-8, Silicon oxide (SiO) RL: PEP (Physical, engineering or chemical process); PRP (Properties); TEM (Technical or engineered material use); PROC (Process); USES (Uses) (sheet materials with iridescent interference color with reflective metal layers, transparent metal layers, and translucent metal layers) 7631-86-9, Silicon dioxide, uses IT RL: PEP (Physical, engineering or chemical process); PRP (Properties); TEM (Technical or engineered material use); PROC (Process); USES (Uses) (sheet materials with iridescent interference color with reflective metal layers, transparent metal layers, and translucent metal layers) 7631-86-9 HCAPLUS RNSilica (7CI, 8CI, 9CI) (CA INDEX NAME) CN

o = si = o

L72

AN1995:954798 HCAPLUS DN 123:347478 Metal foils or laminates precoated with TIvapor-deposited layers and an adhesion-promoting layer Chiang, Shiuh-Kao; Prokop, Mary K.; Kalnoki-Kis, Tibor ΙN Gould Electronics Inc., USA PA Eur. Pat. Appl., 26 pp. SO CODEN: EPXXDW

ANSWER 16 OF 20 HCAPLUS COPYRIGHT 2002 ACS

```
DT
     Patent
     English
LA
     ICM C23C028-00
IC
     ICS C23C016-56; B32B015-20
     56-6 (Nonferrous Metals and Alloys)
CC
     Section cross-reference(s): 42, 76
FAN.CNT 1
     PATENT NO.
                      KIND
                            DATE
                                           APPLICATION NO.
                                                            DATE
     EP 678596
                            19951025
                                           EP 1995-302699
PI
                       A1
                                                            19950421
        R: FR, GB, IT
    CA 2147334
                            19951023
                                           CA 1995-2147334
                       AA
                                                            19950419
    BR 9501605
                                           BR 1995-1605
                       Α
                            19951219
                                                            19950420
                                           AU 1995-17826
    AU 9517826
                            19951102
                       Α1
                                                            19950421
                      A 19951206
                                           CN 1995-104712
    CN 1112877
                                                            19950421
                                           JP 1995-97326
     JP 08041625
                       A2
                          19960213
                                                            19950421
    US 5709957
                                                           19960916
                           19980120
                                           US 1996-713100
                      A
                                           US 1997-846080
                            20010619
    US 6248401
                       В1
                                                            19970425
PRAI US 1994-232820
                       Α
                            19940422
    US 1996-713100
                            19960916
                       AЗ
OS
    MARPAT 123:347478
    Metal foils (esp. Cu foils for elec. printed circuits) are
AΒ
    typically precoated with vapor-deposited Zn, coated with SiO2 or
    Al203, and treated with an adhesion-promoting top layer (esp. organosilane
     or polymer resin), and are suitable for manuf. of laminates.
     The foils can be precoated on one or both sides, and can be coated with
    elec. insulating top layer over the adhesion-promoting layer.
    The Cu foils manufd. by electrodeposition and finished by the precoating
    can be bonded to epoxy-type boards for elec. printed-circuit applications.
    copper foil precoating bonding elec circuit; zinc coating metal
ST
     foil bonding laminate; organosilane bonding metal foil
     laminate; epoxy bonding copper foil precoating silane
    Metals, processes
IT
    RL: PEP (Physical, engineering or chemical process); PROC (Process)
        (coated; foils precoated with vapor-deposited and adhesion-promoting
       layers for lamination)
    Polymers, processes
IT
     RL: PEP (Physical, engineering or chemical process); PROC (Process)
        (coating interlayers; metal foils precoated with
       vapor-deposited and adhesion-promoting polymer layers for
        lamination)
    Epoxy resins, processes
ΙT
      Polyesters, processes
     RL: PEP (Physical, engineering or chemical process); PROC (Process)
        (lamination with; metal foils precoated with
       vapor-deposited and adhesion-promoting polymer layers for
        lamination)
    Lamination
ΙT
        (metal foil to dielec. strip; foils precoated with
        vapor-deposited and adhesion-promoting layers for lamination)
     Electric insulators and Dielectrics
IT
        (coatings, on foils; metal foils precoated with
        vapor-deposited and adhesion-promoting polymer layers for
        lamination or elec. insulation)
IT
     Silanes
     RL: PEP (Physical, engineering or chemical process); PROC (Process)
        (organo-, interlayer; foils precoated with vapor-deposited
       metal and adhesion-promoting organosilane layers for
        lamination)
    Electric circuits
IT
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09/871896 Page 36

UHLIR

```
(printed, boards, laminated; copper foils precoated with
        vapor-deposited and adhesion-promoting polymer layers for lamination or
        elec. insulation)
               2530-83-8, 3-Glycidoxypropyltrimethoxysilane
IT
     78-10-4
     RL: PEP (Physical, engineering or chemical process); PROC (Process)
        (adhesion promoter with; copper foils precoated with vapor-deposited
       metal and adhesion-promoting organosilane layers for
        lamination)
     7429-90-5, Aluminum, processes 7439-95-4, Magnesium, processes
{	t IT}
     7439-96-5, Manganese, processes 7440-02-0, Nickel, processes
                                                                      7440-22-4
     , Silver, processes 7440-31-5, Tin, processes 7440-32-6,
     Titanium, processes 7440-47-3, Chromium, processes 7440-48-4,
     Cobalt, processes 7440-74-6, Indium, processes
     RL: PEP (Physical, engineering or chemical process); PROC (Process)
        (coating interlayer; copper foils precoated with vapor-deposited
       metal and organosilane layers for lamination)
     1344-28-1, Alumina, processes 7631-86-9, Silica,
IT
     processes
     RL: PEP (Physical, engineering or chemical process); PROC (Process)
        (coating; metal foils precoated with metal and
        oxide and adhesion-promoting layers for lamination)
IT
     7440-66-6, Zinc, processes
    RL: PEP (Physical, engineering or chemical process); PROC (Process)
        (coating; metal foils precoated with vapor-deposited zinc and
        adhesion-promoting layers for lamination)
     7440-50-8, Copper, processes
\operatorname{IT}
     RL: PEP (Physical, engineering or chemical process); PROC (Process)
        (lamination; foils precoated with vapor-deposited zinc and
       adhesion-promoting layers for lamination)
     7631-86-9, Silica, processes
IT
     RL: PEP (Physical, engineering or chemical process); PROC (Process)
        (coating; metal foils precoated with metal and
        oxide and adhesion-promoting layers for lamination)
     7631-86-9 HCAPLUS
RN
     Silica (7CI, 8CI, 9CI) (CA INDEX NAME)
CN
0 = Si = 0
L72
    ANSWER 17 OF 20 HCAPLUS COPYRIGHT 2002 ACS
AN
    1991:67429 HCAPLUS
    114:67429
DN
    Vapor-deposited films released from anodized metal substrates, especially
TI
    for bonding to heat-sensitive parts
    Rosenfeld, Aron Marcus; Smits, Paul
IN
    Alcan International Ltd., Can.
PA
    Eur. Pat. Appl., 12 pp.
SO
    CODEN: EPXXDW
\mathsf{DT}
    Patent
    English
LA
IC
    ICM C23C028-00
    ICS C25D011-02; C23C014-08
     56-6 (Nonferrous Metals and Alloys)
CC
     Section cross-reference(s): 38, 73
FAN.CNT 1
     PATENT NO.
                      KIND
                            DATE
                                           APPLICATION NO.
                                                            DATE
                    A1 19900808
PΙ
    EP 381509
                                           EP 1990-301083
                                                           19900202
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R: AT, BE, CH, DE, US 5156720 A JP 02290960 A2 BR 9000472 A PRAI CA 1989-589923 AB Anodized layers on refr

R: AT, BE, CH, DE, DK, ES, FR, GB, GR, IT, LI, LU, NL 5156720 A 19921020 US 1989-306505 19890203 52290960 A2 19901130 JP 1990-24993 19900202 5000472 A 19910115 BR 1990-472 19900202 5989-589923 19890202

Anodized layers on refractory metal (Ta, Nb, Zr, Hf, or Ti) or alloy substrates (esp. in the presence of a fluoride in the bath to decrease adhesion) are vapor deposited and then mech. sepd., and can be bonded to other substrates not suitable for vapor deposition (esp. plastics). The anodized films are optionally coated with multiple layers for optical applications before detachment and rebonding. The process is suitable for continuous operation esp. by using a rotating drum app., and/or for manuf. of laminated composites. Thus, Ta-coated Al foil was anodized to form 61.9-nm Ta2O5 film, and then coated with alternating SiO2 and TiO2 films optimized for high reflectance at the wavelength of 550 nm. The coated foil was laminated with a polyester sheet, and the anodized Al foil was peeled away to expose the reflective film on the polyester.

ST coating anodized metal lamination; polymer vapor coating film bonding; optical coating lamination polyester

IT Paper Textiles

(coatings for, rebonding of high-temp. from anodized metal substrates detached)

IT Lamination

(films from detached coatings on anodized metal substrates for)

IT 16984-48-8, Fluoride, uses and miscellaneous RL: USES (Uses)

(anodized and coated layers with, for detachment and rebonding)

7429-90-5, Aluminum, uses and miscellaneous 7440-03-1, Niobium, uses and miscellaneous 7440-32-6,

Titanium, uses and miscellaneous 7440-58-6, Hafnium, uses and miscellaneous 7440-67-7, Zirconium, uses and miscellaneous

(coating on anodized, detachable, for rebonding on heat-sensitive substrates)

L72 ANSWER 18 OF 20 WPIX COPYRIGHT 2002 DERWENT INFORMATION LTD

AN 1984-136132 [22] WPIX

RL: USES (Uses)

DNN N1984-100904 DNC C1984-057365

TI Mfg. evaporated film of crystalline thermoplastic resin - by laminating metal light reflecting layer to thermoplastic polymer.

DC A17 A23 A94 P73

PA (TEIJ) TEIJIN LTD

CYC 1

PI JP 58183245 A 19831026 (198422) * 5p

ADT JP 58183245 A JP 1982-65428 19820421

PRAI JP 1982-65428 19820421

IC B32B015-08; C08J007-04

AB JP 58183245 A UPAB: 19930925

Process comprises laminating a light reflecting layer of metal on the surface of a base material film made of a thermoplastic polymer. The base material film has static friction coefft. between films below 0.7, limit load above 5 kg and total haze in 25 micron thickness below 3%.

Base material plastic film is pref. of crystalline thermoplastic resin such as **polyester** partic. **PET**, polyethylene-2,6-naphthalene dicarboxylate, polyamide, high density

UHLIR 09/871896 Page 39

polyethylene, isotactic polypropylene. Metal is e.g. Ag or Al. The biaxial orientation film is pref. obtd. by adding fine particles of inert material such as titania, silica, aluminosilicate, CaCO3, Ca phosphate to the base material, forming into film and drawing biaxially. Film is useful for solar film, ID card, microfilm, transparent heat insulating film, film for protection of window glass, etc. The film has enhanced lustre, clearness of specular image and smoothness. 0/0 CPI GMPI FS FA AB CPI: A11-C04B; A12-S06B MC L72 ANSWER 19 OF 20 WPIX COPYRIGHT 2002 DERWENT INFORMATION LTD 1979-83096B [46] WPIX ANLaminated prod. having high electroconductivity - prepd. by ΤI sandwiching metal film layer and transparent substrate between layers of high refractivity transparent dielectric film. DC A23 A32 A94 P73 PA(TEIJ) TEIJIN LTD CYC 1 JP 54127990 PIA 19791004 (197946) * JP 61009143 B 19860320 (198616) PRAI JP 1978-35569 19780.329 B32B007-02; B32B009-00; B32B015-08; B32B033-00 IC JP 54127990 A UPAB: 19930901 AB Metal film layer (e.g. of Ag or Ag-Cu alloy, of thickness 50-500 angstroms) and a transparent substrate (e.g., PET, polycarbonate, etc.) are sandwiched between layers of highly refractive transparent dielectric film (e.g. TiO2 derived, e.g. from an alkyl titanate, SiO2 or ZnO), >=1 layer of which comprises a layer formed physically of thickness <=100 angstroms in direct contact with the metal film layer and a layer formed chemically of thickness >= 30 angstroms. Laminated prods. having high electroconductivity, selective light transmission and high durability are prepd. inexpensively. CPI GMPI FS FA AB CPI: A09-A02; A09-A03; A11-B09D; A12-S06C MC L72 ANSWER 20 OF 20 HCAPLUS COPYRIGHT 2002 ACS AN 1977:553053 HCAPLUS 87:153053 DN Stampable thermoplastic sheet reinforced with multilength fiber TISegal, Leon IN Allied Chemical Corp., USA PAU.S., 13 pp. SO CODEN: USXXAM DT Patent English LA B32B005-16 IC NCL 428283000 37-2 (Plastics Fabrication and Uses) CC FAN.CNT 1 PATENT NO. KIND DATE APPLICATION NO. DATE _____ US 4044188 A 19770823 US 1975-564019 19750401 ΡI PRAI US 1972-293975 19721002 A 3-layer laminate consisting of 2 outer layers of AB thermoplastic resin contg. short glass fibers and a



particulate **filler**, and a core layer of glass fiber mat, was prepd., preheated, and rapidly stamped on **metal** forming equipment at low temp. to give uniform moldings with good mech. properties and improved surface smoothness. Thus, sheets prepd. from mixts. of nylon 6 [25038-54-4] pellets 38.9, **kaolin** filler (av. particle size 10 .mu.) 38.9, and short glass fibers (length 1/8 in.) 22.2% were compression molded as the 2 outer layers of a 3-layer laminate in which a glass mat formed the core layer. The molding was carried out at 100 psi and 270.degree. and the composite sheet contained nylon 35.5, **kaolin** 35.5, short glass fiber 20.2, and glass mat reinforcement 8.8%. The laminate was preheated to 270.degree. and shaped in a deep drawing press at 140.degree. in 10 sec at 800 psi. After cooling, the surface roughness was .ltoreq.55 .mu.in.

ST nylon reinforced deep drawing; glass fiber laminate drawing

IT Kaolin, uses and miscellaneous

RL: USES (Uses)

(nylon reinforced by glass fibers and, cold drawing of laminates of)

IT Glass fibers, uses and miscellaneous

RL: USES (Uses)

(plastics reinforced by, cold drawing of laminates of)

IT Novaculite

RL: USES (Uses)

(poly(ethylene terephthalate) reinforced by glass fibers and, cold drawing of laminates of)

IT Molding of plastics and rubbers

(cold-drawing, of glass fiber-reinforced laminates)

IT 9003-07-0 25038-54-4, uses and miscellaneous 25038-59-9, uses and miscellaneous

RL: USES (Uses)

(glass fiber-reinforced, cold drawing of laminates of)

IT 14807-96-6, uses and miscellaneous

RL: USES (Uses)

(polypropylene reinforced by glass fibers and, cold drawing of laminates of)